

MIC7401

Configurable Power Management Device for Low-Power FPGA, ASICs, and Processors

Features

- Input Voltage: 2.4V to 5.5V
- Five Independent Synchronous Bucks up to 3A
- One Independent Non-Synchronous Boost 200 mA
- 200 µA Quiescent Current (All Regulators On)
- 5 µA Typical Shutdown Current
- 93% Peak Buck Efficiency, 85% Typical Efficiency at 1 mA
- · Dual Power Modes: Standby and Normal Mode
- I²C Interface up to 3.4 MHz
- I²C On-the-Fly EEPROM Programmability, Featuring:
 - Buck and Boost Output Voltage Scaling
 - Power-on-Reset Threshold and Delay
 - Power-Up Sequencing/Sequencing Delay
 - Buck and Boost Current-Limit
 - Buck and Boost Pull-Down when Disabled
 - Individual ON, OFF, and Standby Modes
 - Soft-Start and Global Power Good Masking
- · 23 µA Buck Typical Quiescent Current
- 70 µA Boost Typical Quiescent Current
- 1.5% Output Accuracy over Temperature/Line/Load
- 2.0 MHz Boost Switching Frequency
- 1.3 MHz Buck Operation in Continuous Mode
- Ultra-Fast Buck Transient Response
- 12 mm x 8.55 mm x 1.25 mm Solution Size (Top Layer)
- Thermal Shutdown and Current-Limit Protection
- 36-Pin 4.5 mm x 4.5 mm x 0.85 mm FQFN Package (0.4 mm Pitch)
- -40°C to +125°C Junction Temperature Range

Applications

- Point-of-Sale (POS)
- Servers
- Network Systems
- 3D Glasses
- Infotainment

General Description

The MIC7401 is a powerful, highly-integrated, configurable, power-management IC (PMIC) featuring five synchronous buck regulators, one boost regulator, and high-speed I^2C interface with an internal EEPROM.

The device offers two distinct modes of operation, Standby mode and Normal mode, intended to provide an energy optimized solution suitable for portable hand-held and infotainment applications.

In Normal mode, the programmable switching converters can be configured to support a variety of features, including start-up sequencing, timing, soft-start ramp, output voltage levels, current-limit levels, and output discharge for each channel.

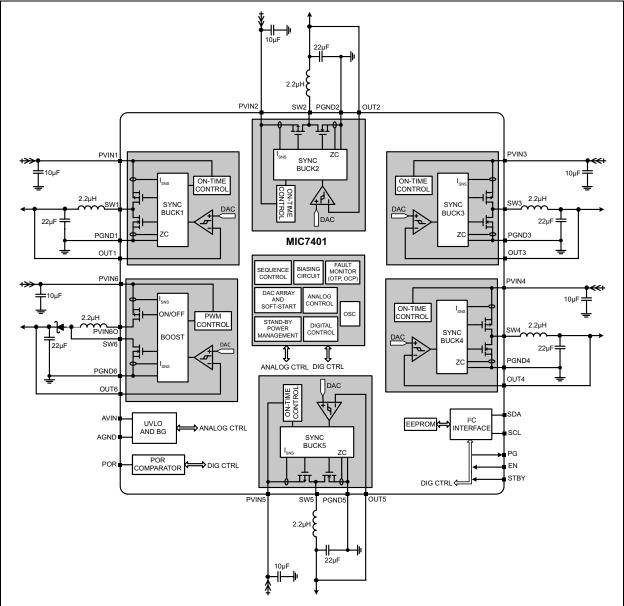
In Standby mode, the PMIC can be configured in a low power state by either disabling an output or by changing the output voltage to a lower level. Independent exit from Standby mode can be achieved either by I²C communication or the external STBY pin.

The device has five synchronous buck regulators with high-speed adaptive on-time control supporting even the challenging ultra-fast transient requirement for core supplies. The one boost regulator provides a Flash memory programming supply that delivers up to 200 mA of output current. The boost is equipped with an output disconnect switch that opens if a short-to-ground fault is detected.

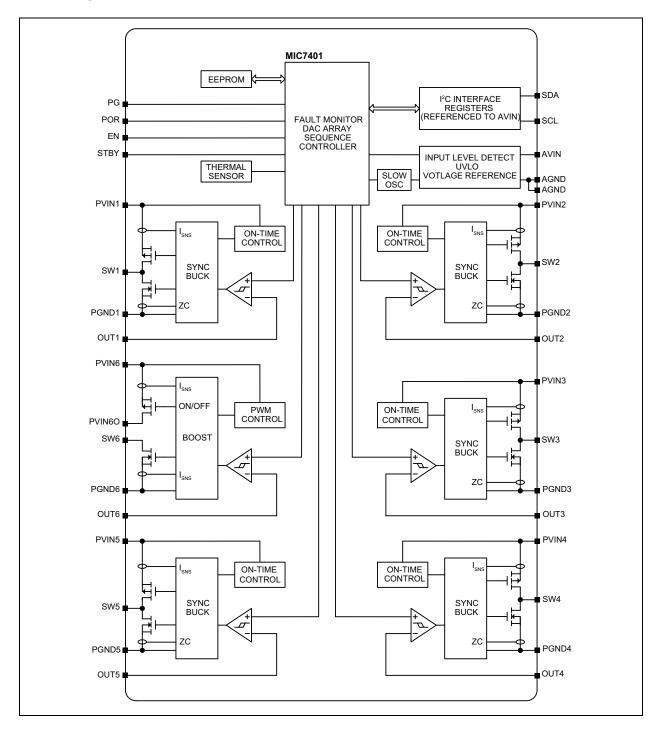
An internal EEPROM enables a single-chip solution across many platforms by allowing the designer to customize the PMIC for their design. Modifications can be made without the need to re-approve a new PMIC, saving valuable design resources and time.

All switchers provide light-load efficiency with HyperLight Load[®] mode for buck and PFM mode for boost. An additional benefit of this proprietary architecture is very low output ripple voltage throughout the entire load range with the use of small output capacitors. The MIC7401 is designed for use with small inductors (down to 0.47 μ H for buck, 1.5 μ H for boost), and an output capacitor as small as 10 μ F for buck, enabling a total solution size of 12 mm × 8.5 mm and less than 1 mm height on top layer.

Typical Application Circuit



Block Diagram



^{© 2018} Microchip Technology Inc.

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Supply Voltages (PV _{IN[1-6]})	–0.3V to +6V
Analog Supply Voltage (AVIN)	–0.3V to +6V
Buck Output Voltages (V _{OUT[1-5]})	–0.3V to +6V
Boost Output Voltage (V _{OUT6})	
Buck Switch Voltages (V _{SW[1-5]})	–0.3V to +6V
Boost Switch Voltage (V _{SW6})	–0.3V to +20V
Power Good Voltage (V _{PG})	–0.3V to AV _{IN}
Power-On Reset Output (V _{POR})	–0.3V to +6V
Enable Voltage (V _{EN})	–0.3V to +6V
Standby Voltage (V _{STBY})	–0.3V to +6V
I ² C IO (V _{SDA} , V _{SCL})	–0.3V to AV _{IN}
AGND to PGND[1-6]	
ESD Rating (Note 1)	HBM: 2 kV; MM: 200V

Operating Ratings ‡

Input Voltage (PV _{IN[1-6]})	+2.4V to +5.5V
Analog Input Voltage (AVIN)	
Buck Output Voltage Range (V _{OUT[1-5]})	+0.8V to +3.3V
Boost Output Voltage Range (V _{OUT6})	
Power Good Voltage (V _{PG})	0V to AV _{IN}
Power-On Reset Output (V _{POR})	0V to AV _{IN}
POR Threshold Voltage (V _{VSLT})	0V to AV _{IN}
Standby Voltage (V _{STBY})	0V to AV _{IN}
I ² C IO (V _{SDA} , V _{SCL})	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability. Specifications are for packaged product only.

‡ Notice: The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD sensitive. Handling precautions are recommended. Human body model, $1.5 \text{ k}\Omega$ in series with 100 pF.

TABLE 1-1: ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $V_{IN} = AV_{IN} = PV_{IN(1-6)} = 5.0V$; $V_{OUT1} = 1.8V$; $V_{OUT2} = 1.1V$; $V_{OUT3} = 1.8V$; $V_{OUT4} = 1.05V$; $V_{OUT5} = 1.25V$; $V_{OUT6} = 12V$. $T_A = +25^{\circ}C$, unless otherwise noted. **Bold** values indicate $-40^{\circ}C \le T_J \le +125^{\circ}C$. Note 1

Parameter	Min.	Тур.	Max.	Units	Conditions	
Input Supply (V _{IN})		•	•	•	·	
Input Voltage Range (AV _{IN} , PV _{IN[1-6]})	2.4		5.5	V	—	
Operating Quiescent Current into AV _{IN} (Note 2, Note 3)	_	200	240	μA	V _{IN} = 5.0V; I _{OUT} = 0A	
Operating Quiescent Current into PV _{IN} (Note 2)	_	0.3	1.0	μA	V _{IN} = 5.0V; I _{OUT} = 0A	
Shutdown Current into (PV _{IN} + AV _{IN})	—	5	—	μA	V _{IN} = 5.0V; V _{EN} = 0V	
Undervoltage Lockout Threshold	2.15	2.25	2.35	V	AV _{IN} Rising	
Undervoltage Lockout Hysteresis	—	150	—	mV	—	
Standby Input (STBY)						
Logic Level High	1.2		_	V	—	
Logic Level Low	—	_	0.4	V	—	
Bias Current into Pin	_		200	nA	V _{STBY} = V _{IN}	
Bias Current out of Pin	_		200	nA	V _{STBY} = 0V	
Rising/Falling Edge Reset Deglitch	_	100	_	μs	—	
Enable Input (EN)			•		•	
Logic Level High	1.2		_	V	V _{EN} Rising, Regulator Enabled	
Logic Level Low	_		0.4	V	V _{EN} Falling, Regulator Shutdown	
Bias Current Into Pin	_		200	nA	V _{VSLT} = V _{IN}	
Bias Current Out of Pin	_		200	nA	V _{VSLT} = 0V	
Power-On-Reset (POR) Comparator	•		•		•	
POR Upper Comparator Range	2.646	2.7	2.754	V	AV _{IN} Rising	
POR Lower Comparator Range	2.548	2.6	2.652	V	AV _{IN} Falling	
Power Reset Output (POR) and Timer	•		•		•	
POR Delay	18	20	22	ms	—	
POR Deglitch Delay		50	_	μs	AV _{IN} Falling	
POR Output Low Voltage	_	75	400	mV	I _{POR} = 10 mA (sinking)	
POR Leakage Current	_		200	nA	V _{POR} = 5.5V	
Global Power Good Output (PG)			•		•	
Buck Power Good Threshold Voltage	87	91	95	%V _{OUT}	V _{OUT[1-5]} Rising	
Buck Hysteresis (Note 4)	_	4	_		V _{OUT[1-5]} Falling	
Boost Power Good Threshold Voltage	87	91	95	%V _{OUT}	V _{OUT[6]} Rising	
Boost Hysteresis (Note 4)	_	380	_	mV	V _{OUT[6]} Falling	
Power Good Output Low Voltage	_	75	400	mV	I _{PG} = 10 mA (sinking)	
Power Good Leakage Current	—	0.01	200	nA	V _{PG} = 5.5V	
Power Good Deglitch Delay		100	_	μs	V _{OUT[1-6]} Falling	
Output Sequencing Delay (Note 4)	0.96	1	1.04	ms		
Thermal Protection						
Thermal Shutdown	_	160	_	°C	T _J Rising	
Thermal Hysteresis		20		°C	—	

^{© 2018} Microchip Technology Inc.

TABLE 1-1: ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $V_{IN} = AV_{IN} = PV_{IN(1-6)} = 5.0V$; $V_{OUT1} = 1.8V$; $V_{OUT2} = 1.1V$; $V_{OUT3} = 1.8V$; $V_{OUT4} = 1.05V$; $V_{OUT5} = 1.25V$; $V_{OUT6} = 12V$. $T_A = +25^{\circ}C$, unless otherwise noted. **Bold** values indicate $-40^{\circ}C \le T_J \le +125^{\circ}C$. Note 1

Buck Output Voltage Accuracy (OUT[1-5])Typical Output Voltage 1 Accuracy (Note 5)-1.5-1.5%Includes Load, Line, and Reference (Note 5)Typical Output Voltage 2 Accuracy (Note 5)-1.5-1.5%Includes Load, Line, and Reference (Note 5)Typical Output Voltage 3 Accuracy (Note 5)-1.5-1.5%Includes Load, Line, and Reference (Note 5)Typical Output Voltage 4 Accuracy (Note 5)-1.5-1.5%Includes Load, Line, and Reference (Note 5)Output Voltage 4 Accuracy (Note 5)-1.5-1.5%Includes Load, Line, and Reference (Note 5)Output Voltage 1 Accuracy (Note 5)-1-1%-Output Voltage 4 Accuracy (Note 5)-1-1%-Output Voltage 5 Accuracy (Note 5)-1-1%-Output Voltage 4 Accuracy (Note 5)-1-1%-Dutput Voltage 5 Accuracy (Note 5)-1-1%-Dutput Voltage 4 Accuracy (Note 5)-1-1%-Dutput Voltage 5 Accuracy (Note 5)-1-1%-Buck Statt-0.05-%V_IN = 3.3V to 5.0VBuck Statt <th>Parameter</th> <th>Min.</th> <th>Тур.</th> <th>Max.</th> <th>Units</th> <th>Conditions</th>	Parameter	Min.	Тур.	Max.	Units	Conditions		
Typical Output Voltage 1 Accuracy -1.5 - 1.5 % Includes Load, Line, and Reference Typical Output Voltage 2 Accuracy -1.5 - 1.5 % Includes Load, Line, and Reference Typical Output Voltage 3 Accuracy -1.5 - 1.5 % Includes Load, Line, and Reference Typical Output Voltage 4 Accuracy -1.5 - 1.5 % Includes Load, Line, and Reference Typical Output Voltage 5 Accuracy -1.5 - 1.5 % Includes Load, Line, and Reference Output Voltage 4 Accuracy (Note 5) -1 - 1 % - Output Voltage 4 Accuracy (Note 5) -1 - 1 % - Output Voltage 4 Accuracy (Note 5) -1 - 1 % - Output Voltage 4 Accuracy (Note 5) -1 - 1 % - Output Voltage 4 Accuracy (Note 5) -1 - 1 % - Output Voltage 4 Accuracy (Note 5) -1 - 1 % - Dutpu	Synchronous Buck (V _{OUT1} - V _{OUT5})		•	•	•	·		
$ \begin{array}{c} (\text{Note 5}) & -1.3 & -$	Buck Output Voltage Accuracy (OUT[1-5])							
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Typical Output Voltage 1 Accuracy (Note 5)	-1.5	—	1.5	%	Includes Load, Line, and Reference		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Typical Output Voltage 2 Accuracy (Note 5)	-1.5	—	1.5	%	Includes Load, Line, and Reference		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Typical Output Voltage 3 Accuracy (Note 5)	-1.5	_	1.5	%	Includes Load, Line, and Reference		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Typical Output Voltage 4 Accuracy (Note 5)	-1.5	_	1.5	%	Includes Load, Line, and Reference		
Output Voltage 2 Accuracy (Note 5) -1 -1 % Output Voltage 3 Accuracy (Note 5) -1 -1 % Output Voltage 4 Accuracy (Note 5) -1 -1 % Output Voltage 5 Accuracy (Note 5) -1 -1 % Output Voltage 5 Accuracy (Note 5) -1 -1 % Load Regulation - 0.1 - % IouT = 10 mA to IoUT(MAX) Line Regulation - 0.05 - % VIN = 3.3V to 5.0V Buck Soft-Start - 0.05 - % VIN = 3.3V; ISW[1-5] = 200 mA High-Side On-Resistance - 54 - mΩ VIN = 5.0V; ISW[1-5] = 200 mA Low-Side On-Resistance - 37 - mΩ VIN = 5.0V; ISW[1-5] = -200 mA Low-Side On-Resistance - 30 - mΩ VIN = 5.0V; ISW[1-5] = -200 mA Low-Side On-Resistance - 30 - mΩ VIN = 5.0V; ISW[1-5] = -200 mA Low-Side On-Re	Typical Output Voltage 5 Accuracy (Note 5)	-1.5	_	1.5	%	Includes Load, Line, and Reference		
Output Voltage 3 Accuracy (Note 5)-1-1%-Output Voltage 4 Accuracy (Note 5)-1-1%-Output Voltage 5 Accuracy (Note 5)-1-1%-Load Regulation-0.1-% $I_{OUT} = 10 \text{ mA to } I_{OUT}(MAX)$ Line Regulation-0.05-% $V_{IN} = 3.3V \text{ to } 5.0V$ Buck Soft-StartSoft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 $\mu s/step$ -Buck Internal MOSFETSHigh-Side On-Resistance-54-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mnQ $V_{IN} = 5.0V; I_{SW$	Output Voltage 1 Accuracy (Note 5)	-1		1	%	—		
Output Voltage 4 Accuracy (Note 5)-1-1%-Output Voltage 5 Accuracy (Note 5)-1-1%-Load Regulation-0.1-% $I_{OUT} = 10 \text{ mA to } I_{OUT(MAX)}$ Line Regulation-0.05-% $V_{IN} = 3.3V \text{ to } 5.0V$ Buck Soft-StartSoft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 $\mu \text{s/step}$ -Buck Internal MOSFETSHigh-Side On-Resistance-54-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-37-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Time (Note 7)-220-nsV_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}Buck Current-Limit (OUT1 - OUT5)-80<	Output Voltage 2 Accuracy (Note 5)	-1		1	%	—		
Output Voltage 5 Accuracy (Note 5)-1-1%-Load Regulation-0.1-% $I_{OUT} = 10 \text{ mA to } I_{OUT(MAX)}$ Line Regulation-0.05-% $V_{IN} = 3.3V \text{ to } 5.0V$ Buck Soft-StartSoft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 $\mu s/step$ -Buck Internal MOSFETSHigh-Side On-Resistance-54-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-40-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-37-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller Timing-80-ns-Fixed On-Time (Note 7)-220-nsV_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0VMinimum OFF-Time-80-ns-Buck 1 Current-Limit (OUT1 - OUT5)-nsBuck 2 Current-Limit Threshold3.075	Output Voltage 3 Accuracy (Note 5)	-1		1	%	—		
Load Regulation0.1% $I_{OUT} = 10 \text{ mA to } I_{OUT(MAX)}$ Line Regulation0.05% $V_{IN} = 3.3V \text{ to } 5.0V$ Buck Soft-StartSoft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 $\mu s/step$ Buck Internal MOSFETSHigh-Side On-Resistance54mΩ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance40mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance37mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance30mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance30mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance30mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Ω $V_{SW[1-5]} = 0V$ Buck Controller Timing80nsFixed On-Time (Note 7)220nsV_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0VMinimum OFF-Time80nsBuck 1 Current-Limit (OUT1 - OUT5)Buck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG Settings <t< td=""><td>Output Voltage 4 Accuracy (Note 5)</td><td>-1</td><td>—</td><td>1</td><td>%</td><td>—</td></t<>	Output Voltage 4 Accuracy (Note 5)	-1	—	1	%	—		
Line Regulation-0.05-% $V_{IN} = 3.3V$ to 5.0VBuck Soft-StartSoft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 μ s/step-Buck Internal MOSFETSHigh-Side On-Resistance-54-mΩ $V_{IN} = 3.3V$; $I_{SW[1-5]} = 200$ mAHigh-Side On-Resistance-40-mΩ $V_{IN} = 5.0V$; $I_{SW[1-5]} = 200$ mALow-Side On-Resistance-37-mΩ $V_{IN} = 3.3V$; $I_{SW[1-5]} = -200$ mALow-Side On-Resistance-30-mΩ $V_{IN} = 5.0V$; $I_{SW[1-5]} = -200$ mALow-Side On-Resistance-30-mΩ $V_{IN} = 5.0V$; $I_{SW[1-5]} = -200$ mALow-Side On-Resistance-30-mΩ $V_{IN} = 5.0V$; $I_{SW[1-5]} = -200$ mAOutput Pull-Down Resistance7590200Ω $V_{SW[1-5]} = 0V$ Buck Controller Timing-80-ns-Fixed On-Time (Note 7)-220-ns-Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)-80-ns-Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Curre	Output Voltage 5 Accuracy (Note 5)	-1		1	%	—		
Buck Soft-StartSoft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 μ s/step—Buck Internal MOSFETSHigh-Side On-Resistance—54—mΩ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ High-Side On-Resistance—40—mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance—37—mΩ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance—30—mΩ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance—30—mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance—30—mΩ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance—30—mΩ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Ω $V_{SW[1-5]} = 0V$ Buck Controller Timing——80—nsFixed On-Time (Note 7)—220—ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time—80—ns—Buck 1 Current-Limit (OUT1 - OUT5)Buck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG Settings	Load Regulation	_	0.1		%	$I_{OUT} = 10 \text{ mA to } I_{OUT(MAX)}$		
Soft-Start (1-5) LSB (Note 4, Note 6)3.844.04.16 μ s/step—Buck Internal MOSFETsHigh-Side On-Resistance—54—mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ High-Side On-Resistance—40—mQ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance—37—mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance—30—mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance—30—mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller TimingFixed On-Time (Note 7)—220—ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time—80—ns—Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125A <td>Line Regulation</td> <td>_</td> <td>0.05</td> <td></td> <td>%</td> <td>V_{IN} = 3.3V to 5.0V</td>	Line Regulation	_	0.05		%	V _{IN} = 3.3V to 5.0V		
Buck Internal MOSFETsHigh-Side On-Resistance-54-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ High-Side On-Resistance-40-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-37-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller Timing-80-ns-Fixed On-Time (Note 7)-220-nsV_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0VMinimum OFF-Time-80-ns-Buck 1 Current-Limit (OUT1 - OUT5)Buck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG Settings<	Buck Soft-Start	•			•	•		
High-Side On-Resistance-54-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = 200 \text{ mA}$ High-Side On-Resistance-40-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance-37-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller TimingFixed On-Time (Note 7)-220-ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4	Soft-Start (1-5) LSB (Note 4, Note 6)	3.84	4.0	4.16	µs/step	_		
High-Side On-Resistance40mQ $V_{IN} = 5.0V; I_{SW[1-5]} = 200 \text{ mA}$ Low-Side On-Resistance37mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance30mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller TimingFixed On-Time (Note 7)220ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time80nsBuck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125 <t< td=""><td>Buck Internal MOSFETs</td><td></td><td></td><td></td><td></td><td>•</td></t<>	Buck Internal MOSFETs					•		
Low-Side On-Resistance-37-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller TimingFixed On-Time (Note 7)-220-ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [X]	High-Side On-Resistance	—	54		mΩ	V _{IN} = 3.3V; I _{SW[1-5]} = 200 mA		
Low-Side On-Resistance-37-mQ $V_{IN} = 3.3V; I_{SW[1-5]} = -200 \text{ mA}$ Low-Side On-Resistance-30-mQ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Q $V_{SW[1-5]} = 0V$ Buck Controller TimingFixed On-Time (Note 7)-220-ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [X]	High-Side On-Resistance	_	40		mΩ	V _{IN} = 5.0V; I _{SW[1-5]} = 200 mA		
Low-Side On-Resistance-30-mΩ $V_{IN} = 5.0V; I_{SW[1-5]} = -200 \text{ mA}$ Output Pull-Down Resistance7590200Ω $V_{SW[1-5]} = 0V$ Buck Controller TimingFixed On-Time (Note 7)-220-ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]- 150 - $\%$ With Respect to Buck [x] Current-Limit	Low-Side On-Resistance	_	37		mΩ			
Buck Controller Timing Fixed On-Time (Note 7) — 220 — ns V _{IN} = 3.3; V _{OUT} = 1.0V; I _{OUT} = 1.0 Minimum OFF-Time — 80 — ns — Buck Current-Limit (OUT1 - OUT5) Buck 1 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Buck 2 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Buck 3 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Buck 4 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Buck 5 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Buck 5 Current-Limit Threshold 4.88 6.1 7.32 A See Table 4-3 for IPROG Settings Buck 5 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Gross High-Side Current-Limit [1-5] — 150 — % With Respect to Buck [x] Current-Limit	Low-Side On-Resistance	—	30		mΩ			
Fixed On-Time (Note 7)- 220 -ns $V_{IN} = 3.3; V_{OUT} = 1.0V; I_{OUT} = 1.0V$ Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold 4.88 6.1 7.32 ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold 3.075 4.1 5.125 ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]- 150 -%With Respect to Buck [x] Current-Limit	Output Pull-Down Resistance	75	90	200	Ω	V _{SW[1-5]} = 0V		
Minimum OFF-Time-80-ns-Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold4.886.17.32ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [x] Current-Limit	Buck Controller Timing							
Buck Current-Limit (OUT1 - OUT5)Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold4.886.17.32ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [x] Current-Limit	Fixed On-Time (Note 7)	—	220		ns	V _{IN} = 3.3; V _{OUT} = 1.0V; I _{OUT} = 1.0A		
Buck 1 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold4.886.17.32ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [x] Current-Limit	Minimum OFF-Time	_	80		ns	—		
Buck 2 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold4.886.17.32ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [x] Current-Limit	Buck Current-Limit (OUT1 - OUT5)							
Buck 3 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 4 Current-Limit Threshold4.886.17.32ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [x] Current-Limit	Buck 1 Current-Limit Threshold	3.075	4.1	5.125	Α	See Table 4-3 for IPROG Settings		
Buck 4 Current-Limit Threshold4.886.17.32ASee Table 4-3 for IPROG SettingsBuck 5 Current-Limit Threshold3.0754.15.125ASee Table 4-3 for IPROG SettingsGross High-Side Current-Limit [1-5]-150-%With Respect to Buck [x] Current-Limit	Buck 2 Current-Limit Threshold	3.075	4.1	5.125	A	See Table 4-3 for IPROG Settings		
Buck 5 Current-Limit Threshold 3.075 4.1 5.125 A See Table 4-3 for IPROG Settings Gross High-Side Current-Limit [1-5] - 150 - % With Respect to Buck [x] Current-Limit	Buck 3 Current-Limit Threshold	3.075	4.1	5.125	A	See Table 4-3 for IPROG Settings		
Gross High-Side Current-Limit [1-5] — 150 — % With Respect to Buck [x] Current-Limit	Buck 4 Current-Limit Threshold	4.88	6.1	7.32	Α	See Table 4-3 for IPROG Settings		
Gross High-Side Current-Limit [1-5] — 150 — % Current-Limit	Buck 5 Current-Limit Threshold	3.075	4.1	5.125	Α	See Table 4-3 for IPROG Settings		
Zero Cross Threshold — 0 — mV Zero crossing detector	Gross High-Side Current-Limit [1-5]	_	150	_	%			
	Zero Cross Threshold	—	0	—	mV	Zero crossing detector		

TABLE 1-1: ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $V_{IN} = AV_{IN} = PV_{IN(1-6)} = 5.0V$; $V_{OUT1} = 1.8V$; $V_{OUT2} = 1.1V$; $V_{OUT3} = 1.8V$; $V_{OUT4} = 1.05V$; $V_{OUT5} = 1.25V$; $V_{OUT6} = 12V$. $T_A = +25^{\circ}C$, unless otherwise noted. **Bold** values indicate $-40^{\circ}C \le T_J \le +125^{\circ}C$. Note 1

Parameter	Min.	Тур.	Max.	Units	Conditions
Boost (V _{OUT6})					
Boost Output Voltage (V _{OUT6})					
Typical Output Voltage Accuracy (Note 5)	-1.5	—	1.5	%	Includes Load, Line, and Reference
Output Voltage Accuracy (Note 5)	-1		1	%	
Load Regulation		0.2		%	I _{OUT6} = 1.0 mA to 200 mA
Line Regulation	—	0.2		%	V_{IN} = 2.4V to 5.5V; I_{OUT6} = 10 mA
V _{OUT6} Discharge Current	111	148	185	mA	V _{IN} = 3.3V; V _{OUT6} = 12V
Boost Soft-Start Step Duration	•				
Soft-Start 6 LSB (Note 4, Note 6)	3.84	4.0	4.16	µs/step	—
Boost Internal MOSFETs	•				
Low-Side On-Resistance		160		mΩ	V _{IN} = 3.3V; I _{SW1} = -100 mA
Low-Side On-Resistance	_	140		mΩ	V _{IN} = 5.0V; I _{SW1} = -100 mA
Boost Disconnect MOSFETs	•				
Disconnect Switch On-Resistance	—	90		mΩ	I _{PVIN6O} = 100 mA; V _{IN} = 3.3V
Disconnect Switch Current-Limit	_	5		А	—
Boost Switching Frequency	•				
Switching Frequency (PWM Mode)	1.92	2.0	2.08	MHz	—
Minimum Duty Cycle	35	40	45	%	—
Maximum Duty Cycle	80	85	90	%	—
Boost Current-Limit	•				
NMOS Current-Limit Threshold		2.24		А	—
I ² C Interface	•				
I ² C Interface (SCL, SDA)					
Low Level Input Voltage			0.4	V	—
High Level Input Voltage	1.2			V	—
Low Level Input Current	-200	0.01	200	nA	—
High Level Input Current	-200	0.01	200	nA	—
SDA Pull-Down Resistance	—	20		Ω	—
SDA Logic 0 Output Voltage	_		0.4	V	I _{SDA} = 3 mA
CLK, DATA Pin Capacitance	_	0.7		pF	—
I ² C Interface Timing (Note 4)		•	•	•	·
	—		100	kHz	Standard Mode
SCL Clock Frequency			400	kHz	Fast Mode
	—	—	3.4	MHz	High Speed Mode (Note 4)

Note 1: Specifications are for packaged product only.

- **2:** Tested in a non-switching configuration.
- **3:** When all outputs are configured to the minimum programmable voltage.
- 4: Guaranteed by design.
- **5:** Not tested in a closed loop configuration.
- 6: The soft-start time is calculated using the following equation: $t_{softstart} = [(V_{OUT_PROGRAM} 0.15)/0.05) \times t_{RAMP}$.
- 7: Buck frequency is calculated using the following equation $f_{SW} = (V_{OUT}/V_{IN}) \times (1/t_{ON})$.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Junction Operating Temperature Range	TJ	-40	_	+125	°C	_	
Ambient Storage Temperature Range	Τ _S	-65	_	+150	°C	—	
Package Thermal Resistance							
Thermal Resistance FQFN-36Ld	θ_{JA}		30	—	°C/W	—	

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

- **Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.
- **Note:** Unless otherwise indicated, $V_{IN} = 5.0V$, $V_{OUT1} = 1.8V$, $V_{OUT2} = 1.1V$, $V_{OUT3} = 1.8V$, $V_{OUT4} = 1.05V$, $V_{OUT5} = 1.25V$, $V_{OUT6} = 12V$, $T_A = +25^{\circ}C$.

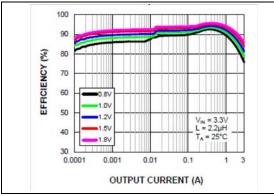


FIGURE 2-1: Buck Efficiency (LDCR = $0 m\Omega$) vs. Output Current.

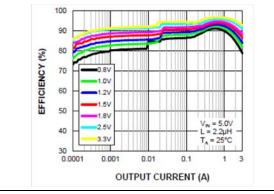


FIGURE 2-2: Buck Efficiency (LDCR = $0 m\Omega$) vs. Output Current.

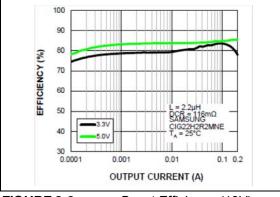


FIGURE 2-3: Boost Efficiency (12V) vs. Output Current.

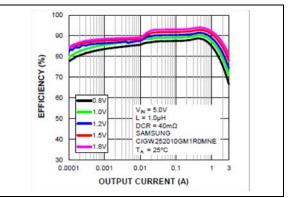


FIGURE 2-4: Buck Efficiency (LDCR = $40 \text{ m}\Omega$) vs. Output Current.

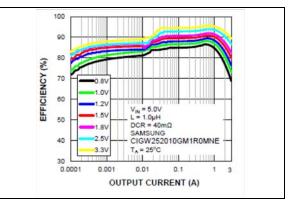


FIGURE 2-5: Buck Efficiency (LDCR = $40 \text{ m}\Omega$) vs. Output Current.

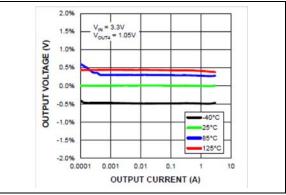


FIGURE 2-6: Out Current.

Output Voltage vs. Output

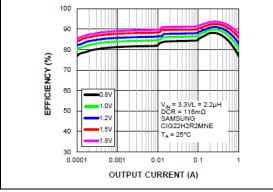


FIGURE 2-7: Buck Efficiency (LDCR = $116 \text{ m}\Omega$) vs. Output Current.

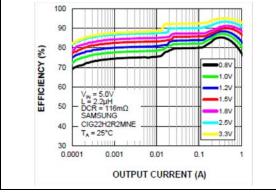


FIGURE 2-8: Buck Efficiency (LDCR = $116 \text{ m}\Omega$) vs. Output Current.

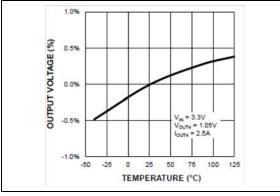


FIGURE 2-9: Output Voltage vs. Temperature.

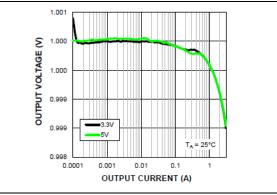


FIGURE 2-10: Buck Output Voltage (1.0V) vs. Output Current.

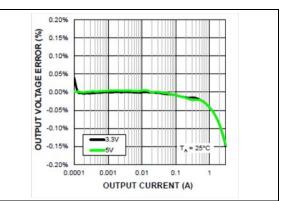


FIGURE 2-11: Buck Output Voltage Regulator vs. Output Current.

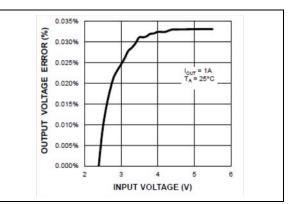


FIGURE 2-12: Buck Line Regulation vs. Input Voltage.

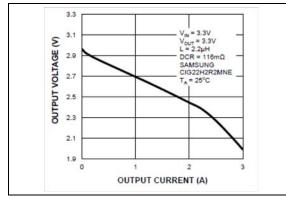


FIGURE 2-13: Dropout Output Voltage vs. Output Current.

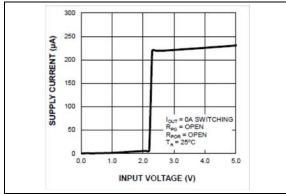


FIGURE 2-14: V_{IN} Operating Supply Current vs. Input Voltage.

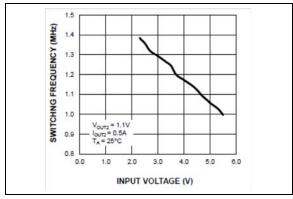
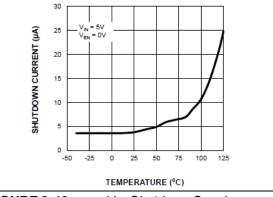


FIGURE 2-15: Buck 2 Switching Frequency vs. Input Voltage.



*FIGURE 2-16: V*_{IN} Shutdown Supply Current vs. Temperature.

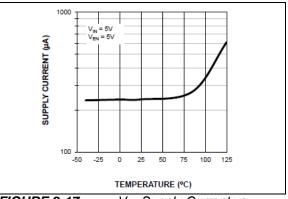


FIGURE 2-17: V_{IN} Supply Current vs. Temperature.

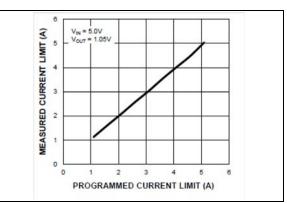
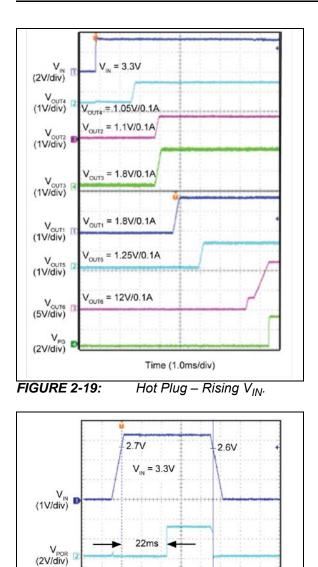
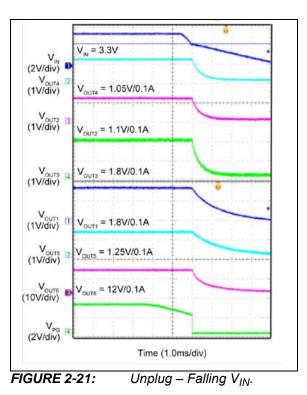


FIGURE 2-18: Programmed Current-Limit vs. Measured Current-Limit.



Time (10ms/div)

POR Timing.



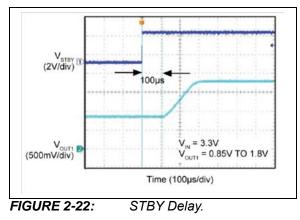
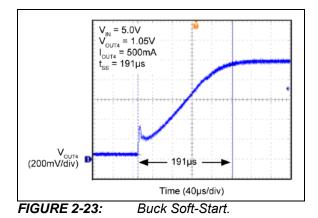
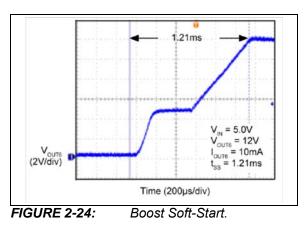
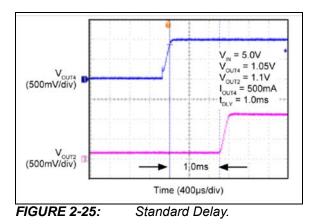


FIGURE 2-20:







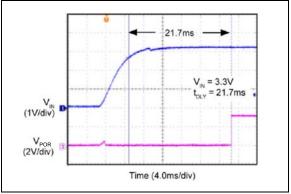
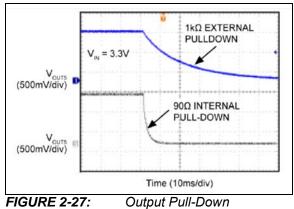


FIGURE 2-26: POR Delay.



Resistance.

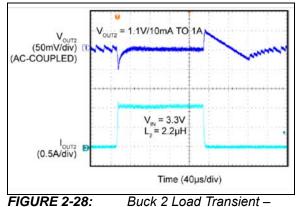
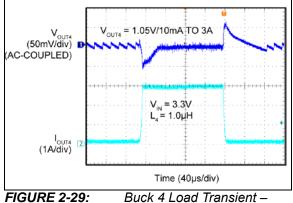


FIGURE 2-28: Buck 2 Load Transient 10 mA to 1A.



10 mA to 3A.

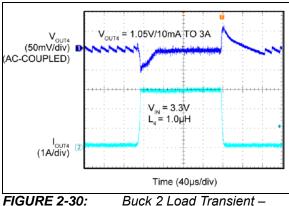
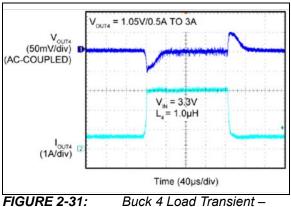


FIGURE 2-30: 200 mA to 1A.



0.5A to 3A.

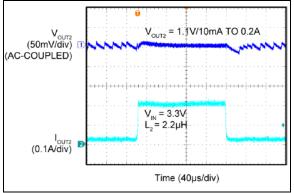


FIGURE 2-32: Buck 2 Load Transient -10 mA to 0.2A.

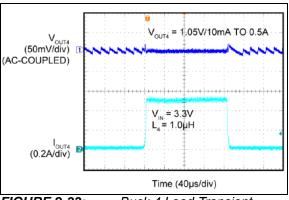


FIGURE 2-33: Buck 4 Load Transient -10 mA to 0.5A.

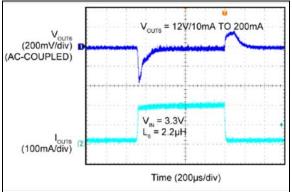
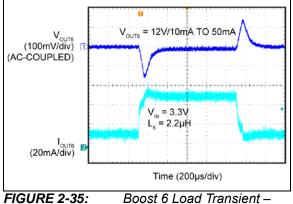


FIGURE 2-34: Boost 6 Load Transient -10 mA to 200 mA.



10 mA to 50 mA.

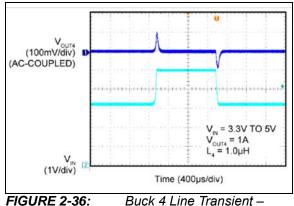
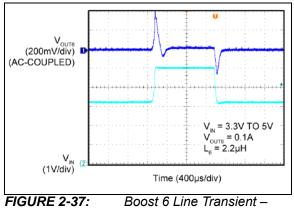
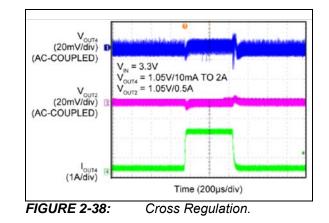


FIGURE 2-36: 3.3V to 5.0V.



3.3V to 5.0V.



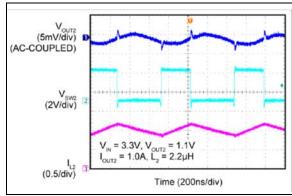


FIGURE 2-39: Buck 2 PWM Switching Waveforms.

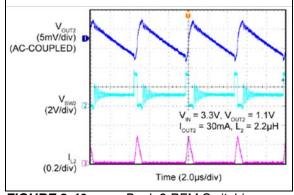


FIGURE 2-40: Waveforms.

Buck 2 PFM Switching

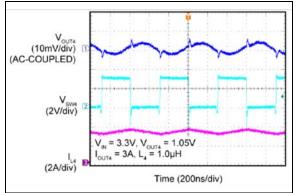


FIGURE 2-41: Buck 4 PWM Switching Waveforms.

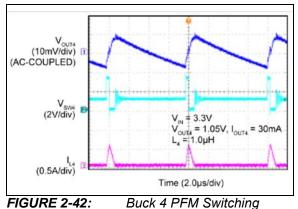
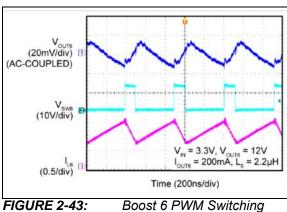


FIGURE 2-42: Waveforms.





Waveforms.

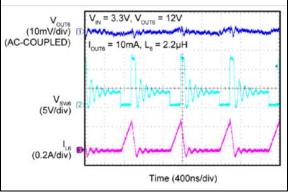


FIGURE 2-44: Boost 6 PFM Switching Waveforms.

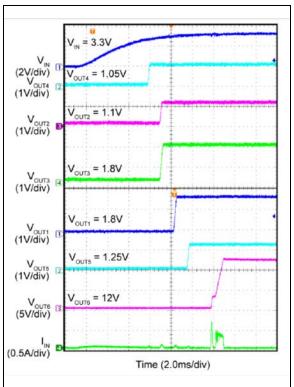


FIGURE 2-45: Input Supply Inrush Current - No Load.

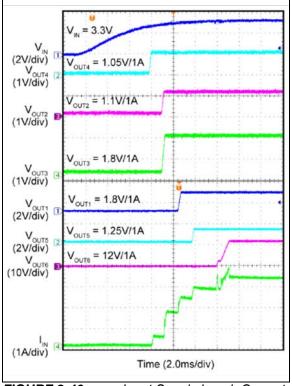
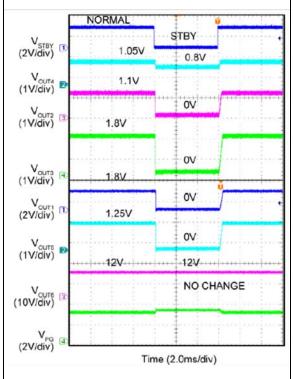
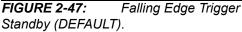


FIGURE 2-46: Input Supply Inrush Current – Loaded.





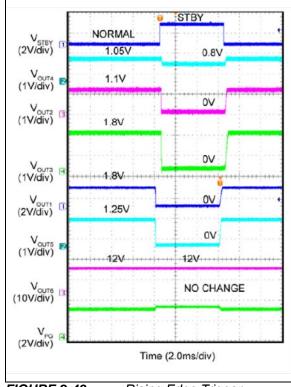


FIGURE 2-48: Rising Edge Trigger Standby.

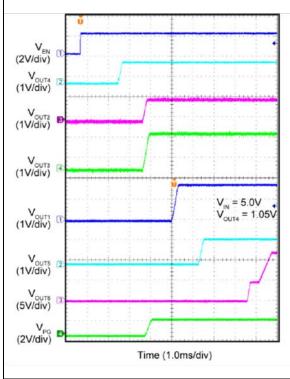


FIGURE 2-49: Power Good with All Outputs Masked (Mask [1-6] = 1).

© 2018 Microchip Technology Inc.

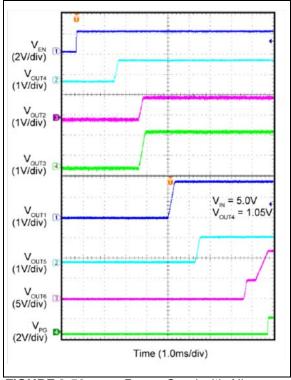


FIGURE 2-50: Power Good with All Outputs Masked except VOUT6 (Mask [1-5] = 1; Mask [6] = 0).

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

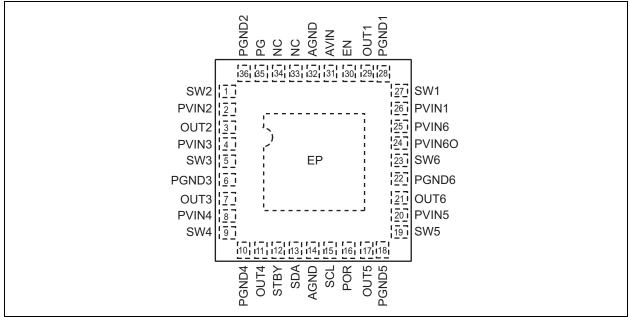


FIGURE 3-1: MIC7401 Pin Configuration.

TABLE 3-1: PIN	FUNCTION TABLE
----------------	----------------

Pin Number	Pin Name	Description
1	SW2	Switch Pin 2 (Output): Inductor connection for the synchronous step-down regulator. Connect the inductor between the output capacitor and the SW2 pin.
2	PVIN2	Power Supply Voltage 2 (Input): Input supply to the source of the internal high-side P-channel MOSFET. An input capacitor between PVIN2 and the power ground PGND2 pin is required and to be placed as close as possible to the IC.
3	OUT2	Output Voltage Sense 2 (Input): This pin is used to sense the output voltage. Connect OUT2 as close to the output capacitor as possible to sense output voltage. Also provides the path to discharge the output through an internal 90Ω resistor when disabled. This pull-down feature is programmed through the PULLD[x] register.
4	PVIN3	Power Supply Voltage 3 (Input): Input supply to the source of the internal high-side P-channel MOSFET. An input capacitor between PVIN3 and the power ground PGND3 pin is required and to be placed as close as possible to the IC.
5	SW3	Switch Pin 3 (Output): Inductor connection for the synchronous step-down regulator. Connect the inductor between the output capacitor and the SW3 pin.
6	PGND3	Power Ground 3: The power ground for the synchronous buck converter power stage. The PGND pin connects to the sources of the internal low-side N-Channel MOSFET, the negative terminals of input capacitors, and the negative terminals of output capacitors.
7	OUT3	Output Voltage Sense 3 (Input): This pin is used to sense the output voltage. Connect OUT3 as close to the output capacitor as possible to sense output voltage. Also provides the path to discharge the output through an internal 9Ω resistor when disabled. This pull-down feature is programmed through the PULLD[x] register.
8	PVIN4	Power Supply Voltage 4 (Input): Input supply to the source of the internal high-side P-channel MOSFET. An input capacitor between PVIN4 and the power ground PGND4 pin is required and to be placed as close as possible to the IC.
9	SW4	Switch Pin 4 (Output): Inductor connection for the synchronous step-down regulator. Connect the inductor between the output capacitor and the SW4 pin.

	ABLE 3-1: PIN FUNCTION TABLE (CONTINUED)					
Pin Number	Pin Name	Description				
10	PGND4	Power Ground 4: The power ground for the synchronous buck converter power stage. The PGND pin connects to the source of the internal low-side N-Channel MOSFET, the negative terminals of input capacitors, and the negative terminals of output capacitors.				
11	OUT4	Output Voltage Sense 4 (Input): This pin is used to sense the output voltage. Connect the OUT4 as close to the output capacitor as possible to sense output voltage. Also provides the path to discharge the output through an internal 90Ω resistor when disabled. This pull-down feature is programmed through the PULLD[x] register.				
12	STBY	Standby Reset (Input): Standby mode allows the total power consumption to be reduced by either lowering a supply voltage or turning it off. The IC can be placed in Standby mode while operating in Normal mode by a high-to-low transition (DEFAULT) on the STBY input. When this occurs, the STBY_MODEB bit will be set to logic 0. Either a low-to-high transition on the STBY pin or an I ² C Write command to the STBY_MODEB bit sets all of the regulators to their Normal mode default settings. This pin can be driven with either a digital signal or open collector output. Do not let this pin float. Connect to ground or AV _{IN} . A pull-down resistor of 100 k Ω or less can also be used. There are both a high-to-low (DEFAULT) and low-to-high normal to standby trigger options available.				
13	SDA	High-Speed mode 3.4 MHz I ² C Data (Input/Output): This is an open-drain, bidirectional data pin. Data is read on the rising edge of the SCL and data is clocked out on the fall-ing edge of the SCL. External pull-up resistors are required.				
14	AGND	Analog Ground: Internal signal ground for all low-power circuits. Connect to ground plane for best operation.				
15	SCL	High-Speed mode 3.4 MHz I ² C Clock (Input): I ² C serial clock line open-drain input. External pull-up resistors are required.				
16	POR	Power-on Reset (Output): This is an open-drain output that goes high after the POR delay time elapses. The POR delay time starts as soon as the AVIN pin voltage rises above the upper threshold set by the PORUP register. The POR output goes low without delay when AVIN falls below the lower threshold set by the PORDN register.				
17	OUT5	Output Voltage Sense 5 (Input): This pin is used to sense the output voltage. Connect OUT5 as close to the output capacitor as possible to sense output voltage. Also provides the path to discharge the output through an internal 90 Ω resistor when disabled. This pull-down feature is programmed through the PULLD[x] register.				
18	PGND5	Power Ground 5: The power ground for the synchronous buck converter power stage. The PGND pin connects to the source of the internal low-side N-Channel MOSFET, the negative terminals of input capacitors, and the negative terminals of output capacitors.				
19	SW5	Switch Pin 5 (Output): Inductor connection for the synchronous step-down regulator. Connect the inductor between the output capacitor and the SW5 pin.				
20	PVIN5	Power Supply Voltage 5 (Input): Input supply to the source of the internal high-side P-channel MOSFET. An input capacitor between PVIN5 and the power ground PGND5 pin is required and to be placed as close as possible to the IC.				
21	OUT6	Output Voltage 6 Sense (Input): This pin is used to sense the output voltage. Connect OUT6 as close to the output capacitor as possible to sense output voltage. Also provides the path to discharge the output through an internal programmable current source when disabled. This pull-down feature is programmed through the PULLD[x] register.				
22	PGND6	Power Ground 6: The power ground for the boost converter power stage. The PGND pin connects to the source of the internal low-side N-Channel MOSFET, the negative terminals of input capacitors, and the negative terminals of output capacitors.				
23	SW6	Switch Pin 6 (Input): Inductor connection for the boost regulator. Connect the inductor between the PVIN6O and SW6 pin.				

TABLE 3-1: PIN FUNCTION TABLE (CONTINUED)

Pin Number	Pin Name	Description
24	PVIN6O	Power Supply Voltage 6 (Output): This pin is the output of the power disconnect switch for the boost regulator. When the boost regulator is on, an internal switch provides a current path for the boost inductor. In shutdown, an internal P-channel MOSFET is turned off and disconnects the boost output from the input supply. This feature eliminates current draw from the input supply during shutdown. An input capacitor between PVIN6O and the power ground PGND6 pin is required and place as close as possible to the IC.
25	PVIN6	Power Supply Voltage 6 (Input): Input supply to the internal disconnect switch.
26	PVIN1	Power Supply Voltage 1 (Input): Input supply to the source of the internal high-side P-channel MOSFET. An input capacitor between PVIN1 and the power ground PGND1 pin is required and to be placed as close as possible to the IC.
27	SW1	Switch Pin 1 (Output): Inductor connection for the synchronous step-down regulator. Connect the inductor between the output capacitor and the SW1 pin.
28	PGND1	Power Ground 1: The power ground for the synchronous buck converter power stage. The PGND pin connects to the source of the internal low-side N-Channel MOSFET, the negative terminals of input capacitors, and the negative terminals of output capacitors.
29	OUT1	Output Voltage Sense 1(Input): This pin is used to sense the output voltage remotely. Connect OUT1 as close to output capacitor as possible to sense output voltage. This feature also provides the path to discharge the output through an internal 90Ω resistor when disabled. The pull-down feature is programmed through the PULLD[x] register.
30	EN	Enable (input): A logic level control of both outputs. The EN pin is CMOS compatible. Logic high = enable, logic low = shutdown. In the OFF state, supply current of the device is greatly reduced (typically 1 μ A). When the EN pin goes high, the start-up sequence is initiated. When EN goes low, all outputs are immediately turned off and the boost output (V _{OUT6}) is completely disconnected from the input voltage. The EN pin must be high for the I ² C to communicate with the IC; otherwise, the IC cannot be programmed. Do not let this pin float. Connect to ground or AV _{IN} . A pull-up resistor of 500 k Ω can also be used.
31	AVIN	Analog Voltage Supply (Input): The start-up sequence begins as soon as the AVIN pin voltage rises above the IC's UVLO upper threshold. The outputs do not turn off until AVIN pin voltage falls below the lower threshold limit. A 2.2 μ F ceramic capacitor from the AVIN pin to AGND pin must be placed next to the IC.
32	AGND	Analog Ground: Internal signal ground for all low-power circuits. Connect directly to the Layer 2 ground plane. Layer 2 is the point where all the PGNDs and AGND are connected. Do not connect PGND and AGND together on the top layer.
33	NC	No Connect. Must be left floating.
34	NC	No Connect. Must be left floating.
35	PG	Global Power Good (Output): This is an open-drain output that is pulled high when all the regulator power good flags are high. If an output falls below the power good threshold or a thermal fault occurs, the global power good flag is pulled low. There is a falling edge deglitch time of 50 μ s to prevent false triggering on output voltage transients. A power good mask feature programmed through the PGOOD_MASK[x] registers can be used to ignore a power good fault. When masked, an individual power good fault will not cause the global power good output to de-assert. Do not connect the power good pull-up resistor to a voltage higher than AV _{IN} .
36	PGND2	Power Ground 2: The power ground for the synchronous buck converter power stage. The PGND pin connects to the source of the internal low-side N-Channel MOSFET, the negative terminals of input capacitors, and the negative terminals of output capacitors.
EP	ePad	Exposed Pad: Must be connected to the GND plane for full output power to be realized.

 TABLE 3-1:
 PIN FUNCTION TABLE (CONTINUED)

4.0 FUNCTIONAL DESCRIPTION

The MIC7401 is one of the industry's most advanced PMIC designed for solid state drives (SSD) on the market today. It is a multi-channel solution which offers software configurable soft-start, sequencing, and digital voltage control (DVC) that minimizes PC board area. These features usually require a pin for programming. However, this approach makes the IC larger by increasing pin count, and also increases BOM cost due to the external components.

The following is a complete list of programmable features:

- Buck output voltage (0.8V 3.3V/50 mV steps)
- Boost output voltage (7.0V 14V/ 200 mV steps)
- Power-on-reset (2.25V 4.25V/50 mV steps)
- Power-on-reset delay (5 ms 160 ms/5 ms steps)
- Power-up sequencing (6 time slots)
- Power-up sequencing delay (0 ms 7 ms/1 ms steps)
- Soft-start (4 µs 1024 µs per step)
- Buck current limit threshold
 - (1.1A to 6.1A/0.5A steps)
- Boost current limit threshold
 (1.76A to 2.6A/0.12A steps)
- Boost pull-down (37 mA to 148 mA/37 mA steps)
- Buck pull-down (90Ω)
- Buck standby output voltage programmable
- · Boost standby output voltage programmable
- · Global power good masking

These features give the system designer the flexibility to customize the MIC7400 for their application. For example, V_{OUT1} current-limit can be programmed to 4.1A and V_{OUT2} can be set to 1.1A. These outputs can be programmed to come up at the same time or 2.0 ms apart. In addition, in power-saving standby mode, the outputs can either be turned off or programmed to a lower voltage. With this programmability, the MIC7401 can be used in multiple platforms.

The MIC7401 buck regulators are adaptive on-time synchronous step-down DC-to-DC regulators. They are designed to operate over a wide input voltage range from 2.4V to 5.5V and provide a regulated output voltage at up to 3.0A of output current. An adaptive on-time control scheme is employed to obtain a constant switching frequency and to simplify the control compensation. The device includes an internal soft-start function that reduces the power supply input surge current at start-up by controlling the output voltage rise time.

The MIC7401 has a current-mode boost regulator that can deliver up to 200 mA of output current and only consumes 70 μ A of quiescent current. The 2.0 MHz switching frequency allows small chip inductors to be used. Programmable overcurrent sensing protects the

boost from overloads and an output disconnect switch opens to protect against a short-circuit condition. Soft-start is also programmable and controls both the rising and falling output.

4.1 Programmable Buck Soft-Start Control

The MIC7401 soft-start feature forces the output voltage to rise gradually, which limits the inrush current during start-up. A slower output rise time will draw a lower input surge current. The soft-start time is based on the least significant bit (LSB) of an internal DAC and the speed of the ramp rate, as shown in Figure 4-1. This illustrates the soft-start waveform for all five synchronous buck converters. The initial step starts at 150 mV and each subsequent step is 50 mV.

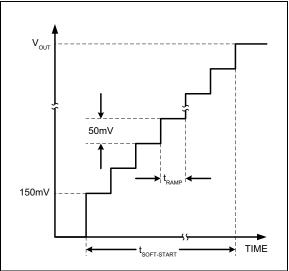


FIGURE 4-1: Buck Soft-Start.

The output ramp rate (t_{RAMP}) is set by the soft-start registers. Each output ramp rate can be individually set from 4 µs to 1024 µs, see Table 4-1 for details.

The soft-start time t_{SS} can be calculated by Equation 4-1:

EQUATION 4-1:

$$t_{SS} = \left(\frac{V_{OUT} - 0.15V}{50mV}\right) \times t_{RAMP}$$

Where:

 t_{SS} = Output rise time. V_{OUT} = Output voltage. t_{RAMP} = Output dwell time.

DS20005618A-page 22

For example:

EQUATION 4-2:

$$t_{SS} = \left(\frac{1.8V - 0.15V}{50mV}\right) \times 8\mu s$$
$$t_{SS} = 264\mu s$$

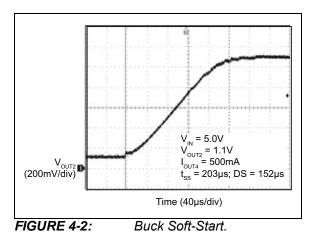
Where:

V_{OUT} = 1.8V t_{RAMP} = 8.0 μs

TABLE 4-1: BUCK OUTPUTS DEFAULT SOFT-START TIME (DEFAULT)

			(,
	V _{OUT}	t _{RAMP}	t _{SS}
V _{OUT1}	1.8V	8 µs	264 µs
V _{OUT2}	1.1V	8 µs	152 µs
V _{OUT3}	1.8V	8 µs	264 µs
V _{OUT4}	1.05V	8 µs	144 µs
V _{OUT5}	1.25V	8 µs	176 µs

Figure 4-2 shows the output of Buck 1 ramping up cleanly, starting from 0.15V to its final 1.1V value.



4.2 Buck Digital Voltage Control (DVC)

The output voltage has a 6-bit control DAC that can be programmed from 0.8V to 3.3V in 50 mV increments. If the output is programmed to a higher voltage, then the output ramps up, as shown in Figure 4-3.

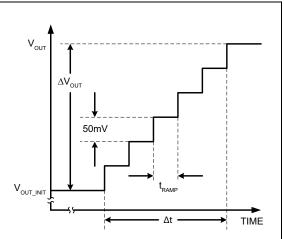


FIGURE 4-3: Buck DVC Control Ramp.

The ramp time is determined by Equation 4-3:

EQUATION 4-3:

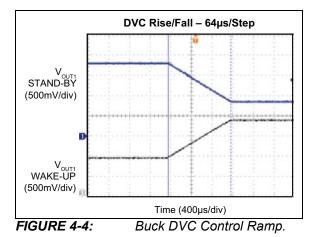
$$\Delta t = \left(\frac{V_{OUT} - V_{OUT_INIT}}{50mV}\right) \times t_{RAMP}$$

Where:

 $\label{eq:Vout_INIT} \begin{array}{l} \mathsf{V}_{\mathsf{OUT_INIT}} = \mathsf{Initial output voltage}. \\ \mathsf{V}_{\mathsf{OUT}} = \mathsf{Final output voltage}. \\ \mathsf{t}_{\mathsf{RAMP}} = \mathsf{Output dwell time}. \end{array}$

When the regulator is set in Standby mode or programmed to a lower voltage, then the output voltage ramps down at a rate determined by the output ramp rate (t_{RAMP}), the output capacitance and the external load. Small loads result in slow output voltage decay and heavy loads cause the decay to be controlled by the DAC ramp rate.

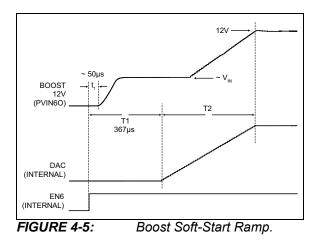
In Figure 4-4, V_{OUT1} is switched to stand-by mode with an I²C command and then switched back to normal mode either by an I²C command or a low-to-high transition of the STBY pin. In this case, the rise and fall times are the same due to a 1A load on V_{OUT1}.

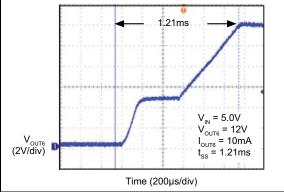


4.3 Programmable Boost Soft-Start Control

The boost soft-start time is divided into two parts as shown in Figure 4-5. T1 is a fixed 367 μ s delay starting from when the internal enable goes high. This delay gives enough time for the disconnect switch to turn on and bring the inductor voltage to V_{IN} before the boost is turned on. There is a 50 μ s delay that is controlled by the parasitic capacitance (C_{GD}) of the disconnect switch before the output starts to rise.

After the T1 period, the DAC output ramp starts, T2. The total soft-start time, t_{SS} , is the sum of both periods. Figure 4-6 displays the actual boost soft-start waveform.









$$t_{SS} = T1 + T2$$

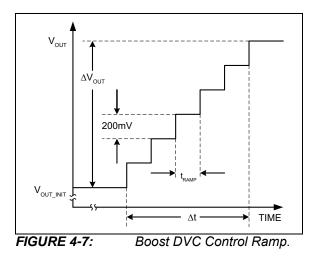
$$T2 = \left(\frac{V_{OUT} - 1.4V}{0.2V}\right) \times t_{RAMP}$$

$$T2 = \left(\frac{12V - 1.4V}{0.2V}\right) \times 16\mu s$$
Where:
T1 = 367 µs
T2 = 040 µs

T2 = 848 μ s t_{SS} = 367 μ s + 848 μ s = 1.215 ms V_{OUT} = Output voltage. t_{RAMP} = Output dwell time = 16 μ s.

4.4 Boost Digital Voltage Control (DVC)

The boost output control works the same way as the buck, except that the voltage steps are 200 mV, see Figure 4-7. When the boost is programmed to a lower voltage, the output ramps down at a rate determined by the output ramp rate (t_{RAMP}), the output capacitance and the external load. During both the ramp up and down time, the power good output is blanked and if the power good mask bit is set to "1".



The ramp time can be computed using the following equation:

Р

EQUATION 4-5:

$$\Delta t = \left(\frac{V_{OUT} - V_{OUT_INIT}}{0.2V}\right) \times t_{RAM}$$

Where:

V_{OUT INIT} = Initial output voltage.

TABLE 4-2: BOOST OUTPUT DEFAULT SOFT-START TIME

_	V _{OUT}	t _{RAMP}	t _{SS}
V _{OUT6}	12V	16 µs	1.215 ms

4.5 Buck Current-Limit

The MIC7401 buck regulators have high-side current-limiting that can be varied by a 4-bit code. If the regulator remains in current-limit for more than seven consecutive PWM cycles, the output is latched off, the overcurrent status register bit is set to 1, the power-good status register bit is set to 0 and the global power good (PG) output pin is pulled low. An overcurrent fault on one output will not disable the remaining outputs. Table 4-3 shows the current-limit register settings verses output current. The current-limit register setting is set at twice the maximum output current.

TABLE 4-3: BUCK CURRENT-LIMIT REGISTER SETTINGS

I _{OUT(MAX)}	I _{PROG}	BINARY	HEX
0.5A	1.1A	1111	F'h
1.0A	2.1A	1101	D'h
1.5A	3.1A	1011	B'h
2.0A	4.1A	1001	9'h
2.5A	5.1A	0111	7'h
3.0A	6.1A	0101	5'h

The output can be turned back on by recycling the input power or by software control. To clear the overcurrent fault by software control, set the enable register bit to "0" then clear the overcurrent fault by setting the fault register bit to "0". This will clear the overcurrent and power good status registers. Now the output can be re-enabled by setting the enable register bit to "1".

During start-up sequencing, once an overcurrent condition is sensed, the fault register is set to "1" and the start-up sequence will stop and no further outputs will be enabled. See Figure 4-9 for default start-up sequence.

4.6 Boost Current-Limit

The boost current-limit features cycle-by-cycle protection. The duty cycle is cut immediately once the current-limit is hit. When the boost current-limit is hit for five consecutive cycles, the FAULT signal is asserted and remains asserted with the boost converter keeping on running until the boost is powered off.

This protects the boost in normal overload conditions, but not in a short-to-ground case. For a short-circuit to ground, the boost current-limit will not be able to limit the inductor current. This short-circuit condition is sensed by the current in the disconnect switch. When the disconnect switch current limit is hit for four consecutive master clock cycles (2 MHz), regardless if the boost is switching or not, both the disconnect switch and boost are latched off automatically and the FAULT signal is asserted.

The output can be turned back on by recycling the input power or by software control. To clear the overcurrent fault by software control, set the enable register bit to "0" then clear the overcurrent fault by setting the fault register bit to "0".

4.7 Global Power Good Pin

The global power-good output indicates that all the outputs are above the 91% limit after the power-up sequence is completed. Once the power-up sequence is complete, the global power good output stays high unless an output falls below its power-good limit, a thermal fault occurs, the input voltage drops below the lower UVLO threshold or an output is turned OFF by setting the enable register bit to "0" unless the PGOOD_MASK[x] bit is set to "1" (Default).

A power-good mask bit can be used to control the global power good output. The power-good mask feature is programmed through the PGOOD_MASK[x] registers and is used to ignore an individual power-good fault. When masked, PGOOD_MASK[x] bit is set to "1", an individual power good fault will not cause the global power good output to de-assert.

If all the PGOOD_MASK[x] bits are set to "1", then the power good output de-asserts as soon as the first output starts to rise. The PGOOD_MASK[x] bit of the last output must be set to "0" to have the PG output stay low until the last output reaches 91% of its final value.

The global power-good output is an open-drain output. A pull-up resistor can be connected to $V_{\rm IN}$ or $V_{OUT}.$ Do not connect the pull-up resistor to a voltage higher than $AV_{\rm IN}.$

4.8 Standard Delay

There is a programmable timer that is used to set the standard delay time between each time slot. The timer starts as soon as the previous time slot's output power good goes high. When the delay completes, the regulators assigned to that time slot are enabled, see Figure 4-8.

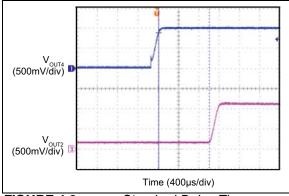


FIGURE 4-8: Standard Delay Time.

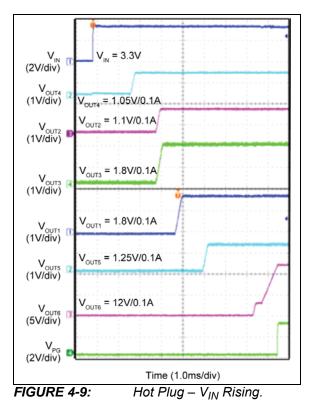
4.9 Power-Up Sequencing

When power is first applied to the MIC7401, all I^2C registers are loaded with their default values from the EEPROM. There is about a 1.5 ms delay before the first regulator is enabled while the MIC7401 goes

through the initialization process. The DELAY register's STDEL bits set the delay between powering up each regulator at initial power up.

The sequencing registers allow the outputs to come up in any order. There are six time slots that an output can be configured to power up in. Each time slot can be programmed for up to six regulators to be turned on at once or none at all.

Figure 4-9 shows an example of this feature. V_{OUT4} is enabled in time slot 1. After a 1 ms delay, V_{OUT2} and V_{OUT3} are enabled at the same time in time slot 2. The 1 ms is the standard delay for all of the outputs and can be programmed from 0 ms to 7 ms in 1 ms steps. Next, V_{OUT1} is powered up in time slot 3 and V_{OUT5} in time slot 4. There are no regulators programmed for time slot 5. Finally, V_{OUT6} is powered up in time slot 6. The global power good output, V_{PG}, goes high as soon as the last output reaches 91% of its final value.



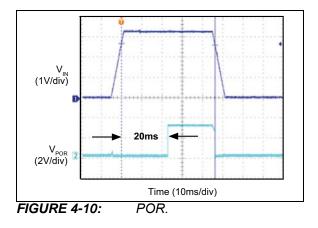
4.10 Global Enable Pin

When the enable pin rises above the enable threshold voltage, the MIC7401 enters its start-up sequence.

4.11 Programmable Power-on-Reset (POR) Delay

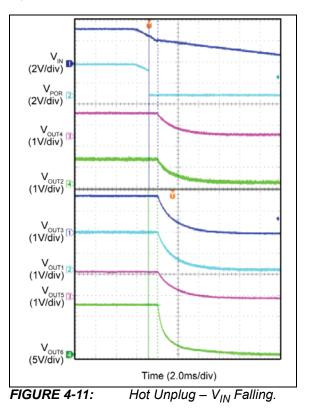
The POR output pin provides the user with a way to let the SOC know that the input power is failing. If the input voltage falls below the power-on reset lower threshold level, the POR output immediately goes low. The lower threshold is set in the PORDN register and the upper threshold uses PORUP register.

The low-to-high POR transition can be delayed from 5 ms to 160 ms in 5 ms increments. This feature can be used to signal the SOC that the power supplies are stable. The PORDEL register sets the delay of the POR pin. The POR delay starts as soon as the AVIN pin voltage rises above the power-on reset upper threshold limit. Figure 4-10 shows the POR operation.



4.12 Power-Down Sequencing

When power is removed from V_{IN} , all the regulators try to maintain the output voltage until the input voltage falls below the UVLO limit of 2.35V as shown in Figure 4-11.



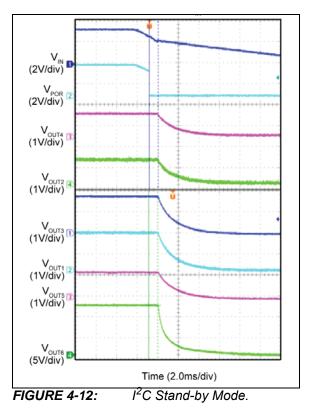
^{© 2018} Microchip Technology Inc.

4.13 Stand-By Mode

In stand-by mode, efficiency can be improved by lowering the output voltage to the standby mode value or turning an output off completely. There are two registers used for setting the output voltage, normal-mode register and stand-by mode register. The default power-up voltages are set in the normal-mode registers.

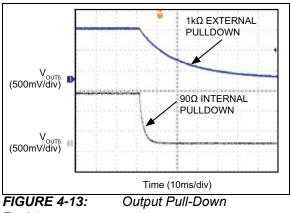
An I^2C write command to the STBY_CTRL_REG register or the STBY pin can be used to set the MIC7401 into stand-by mode. Figure 4-12 shows an I^2C write command implementation. In stand-by mode, the output can be programmed to a lower voltage or turned completely off. When disabled, the output will be soft-discharged to zero if the PULLD[1-6] register are set to 1. If PULLD[x] = 0 the output drifts to PGND at a rate determined by the load current and output capacitance.

In stand-by, if an output is disabled, the global power good output is not affected when the PGOOD_MASK[x] is set to logic 1. If the PGOOD_MASK[x] is set to logic 0, then the global power good flag is pulled low. In Figure 4-12, all the PGOOD_MASK[x] bits are set to logic 1.



4.14 Resistive Discharge

To ensure a known output condition in stand-by mode, the output is actively discharged to ground if the output is disabled. Setting the buck pull-down register field PULLD[1-5] = 1 connects a 90 Ω pull down resistor from OUT[x] to PGND[x] when the MIC7401 is disabled. If PULLD[x] = 0 the output drifts to PGND at a rate determined by the load current and the output capacitance value. The boost has a programmable pull-down current level from 37 mA to 148 mA. In Figure 4-13, the top trace shows the normal pull-down and the bottom trace is with the 90 Ω pull-down.



Resistance.

4.15 STBY Pin

A pin-selectable STBY input allows the MIC7401 to be placed into standby or normal mode. In standby mode, the individual regulator can be turned on or off or the output voltage can be set to a different value. If the regulators are turned off, standby mode cuts the quiescent current by 23 μ A for each buck regulator and 70 μ A for the boost.

Figure 4-14 illustrates the STBY pin operation. A low-to-high transition on the STBY pin switches the output from standby mode to normal mode. There is a 100 μ s STBY de-glitch time to eliminate nuisance tripping then all the regulators are enabled at the same time and ramp up with their programmed ramp rates. A high-to-low transition on the STBY pin switches the output from normal mode to standby mode.

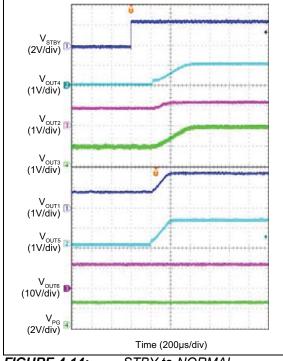
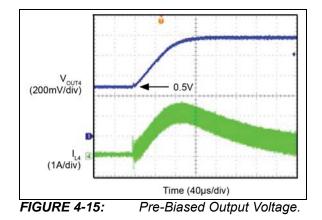


FIGURE 4-14: STBY-to-NORMAL Transition (DEFAULT).

4.16 Safe Start-Up into a Pre-Biased Output

The MIC7401 is designed for safe start-up into a pre-biased output. This prevents large negative inductor currents that can cause the output voltage to dip and excessive output voltage oscillations. A zero crossing comparator is used to detect a negative inductor current. If a negative inductor current is detected, the low-side synchronous MOSFET functions as a diode and is immediately turned off.

Figure 4-15 shows a 1V output pre-bias at 0.5V at start-up, see V_{OUT4} trace. The inductor current, trace I_{L4} , is not allowed to go negative by more than 0.5A before the low-side switch is turned off. This feature prevents high negative inductor current flow in a pre-bias condition that can damage the IC.



4.17 Buck Regulator Power Dissipation

The total power dissipation in a MIC7401 is a combination of the five buck regulators and the boost dissipation. The buck regulators (OUT1 to OUT5) dissipation is approximately the switcher's input power minus the switcher's output power and minus the power loss in the inductor:

EQUATION 4-6:

$$P_{D_{BUCK}} \approx V_{IN} \times I_{IN} - V_{OUT} \times I_{OUT} - P_{L_{LOSS}}$$

While the boost power dissipation is estimated by Equation 4-7:

EQUATION 4-7:

$$\begin{split} P_{D_\text{BOOST}} &\approx V_{IN} \times I_{IN} - V_{OUT} \times I_{OUT} - P_{L_\text{LOSS}} \\ &- V_f \times I_{OUT} \end{split}$$

Although the maximum output current for a single buck regulator can be as much as 3A, the MIC7401 will thermal limit and will not support this high output current on all outputs at the same time.

4.18 Total Power Dissipation

The total power dissipation in the MIC7401 package is equal to the sum of the power loss of each regulator:

EQUATION 4-8:

$$P_{D_{-}\text{TOTAL}} \approx SUM(P_{D_{-}\text{SWITCHERS}})$$

Once the total power dissipation is calculated, the IC junction temperature can be estimated using Equation 4-9:

EQUATION 4-9:

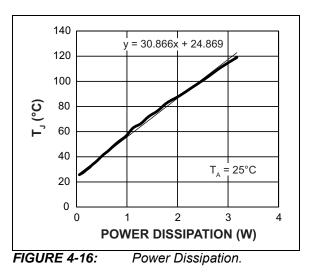
$$T_{J(MAX)} \approx T_A + P_{D_\text{TOTAL}} \times \theta_{JA}$$

Where:

 $T_{J(MAX)}$ = The maximum junction temperature. T_A = The ambient temperature. θ_{JA} = The junction-to-ambient thermal resistance

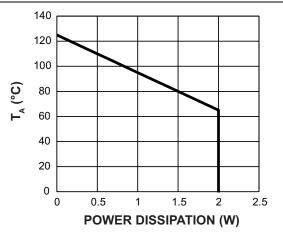
of the package (30°C/W).

Figure 4-16 shows the measured junction temperature versus power dissipation of the MIC7401 evaluation board. The actual junction temperature of the IC depends upon many factors. The significant factors influencing the die temperature rise are copper thickness in the PCB, the surface area available for convection heat transfer, air flow and power dissipation from other components, including inductors, SOCs and processor ICs. It is good engineering practice to measure all power components temperature during the final design review using a thermal couple or IR thermometer, see the Thermal Measurements sub-section for details.



4.19 Power Derating

The MIC7401 package has a 2W power dissipation limit. To keep the IC junction temperature below a 125°C design limit, the output power has to be limited above an ambient temperature of 65°C. Figure 4-17 shows the power dissipation derating curve.





The maximum power dissipation of the package can be calculated by Equation 4-10:

EQUATION 4-10:

$$P_{D(MAX)} \approx \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where:

- $T_{J(MAX)}$ = The maximum junction temperature (125°C).
- T_A = The ambient temperature.
- θ_{JA} = The junction-to-ambient thermal resistance of the package (30°C/W).

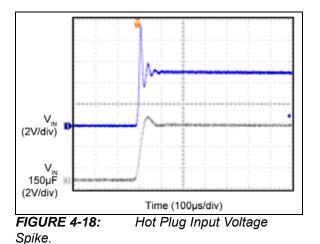
4.20 Overtemperature Fault

An overtemperature fault is triggered when the IC junction temperature reaches 160° C. When this occurs, both the overtemperature fault flag is set to "1", the global power good output is pulled low and all the outputs are turned off. During the fault condition the I²C interface remains active and all registers values are maintained.

When the die temperature decreases by 20°C the overtemperature fault bit can be cleared. To clear the fault, either recycle power or write a logic "0" to the over temperature fault register. Once the fault bit is cleared, the outputs power up to their default values and are sequenced according to the time slot settings.

4.21 Input Voltage "Hot Plug"

High voltage spikes of twice the input voltage can appear on the MIC7401 PVIN pins if a battery pack is hot-plugged to the input supply voltage connection as shown in Figure 4-18 (Trace 1). These spikes are due to the inductance of the wires to the battery and the very low inductance and ESR of the ceramic input capacitors. This problem can be solved by placing a 150 μ F POS capacitor across the input terminals. Figure 4-18 (Trace 2) shows that the high voltage spike is greatly reduced to a value below the maximum allowable input voltage rating.



4.22 Thermal Measurements

Measuring the IC's case temperature is recommended to ensure it is within its operating limits. Although this might seem like a very elementary task, it is easy to get erroneous results. The most common mistake is to use the standard thermal couple that comes with a thermal meter. This thermal couple wire gauge is large (typically 22 gauge) and behaves like a heatsink, resulting in a lower case measurement.

Two reliable methods of temperature measurement are a smaller thermocouple wire or an infrared thermometer. If a thermal couple wire is used, it must be constructed of 36 gauge wire or higher (smaller wire size) to minimize the wire heat-sinking effect. In addition, the thermal couple tip must be covered in either thermal grease or thermal glue to make sure that the thermal couple junction is making good contact with the case of the IC. Omega brand thermal couple (5SC-TT-K-36-36) is adequate for most applications.

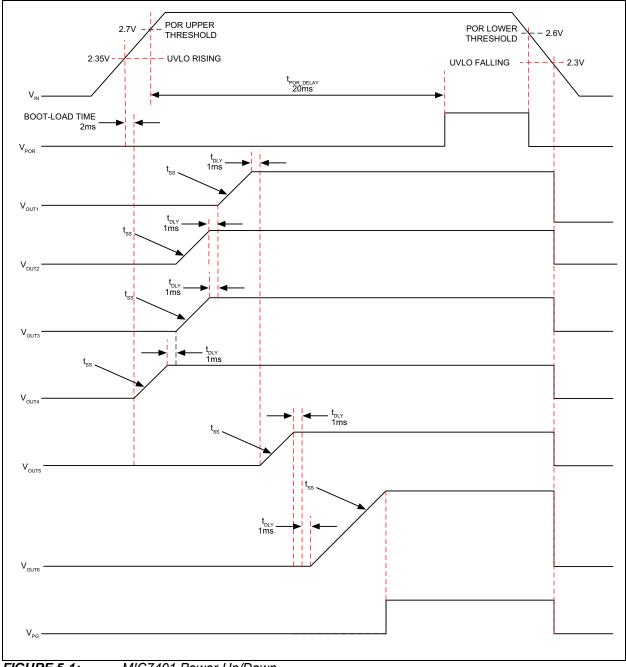
Whenever possible, an infrared thermometer is recommended. The measurement spot size of most infrared thermometers is too large for an accurate reading on a small form factor ICs. However, an IR thermometer from Optris has a 1 mm spot size, which makes it a good choice for measuring the hottest point on the case. An optional stand makes it easy to hold the beam on the IC for long periods of time.

5.0 TIMING DIAGRAMS

5.1 Normal Power-Up Sequence for Outputs

The STDEL register sets the delay between powering up of each regulator at initial power-up (see power-up sequencing in Figure 5-1). Once all the internal power good registers PGOOD[1-6] are all "1", then the global PG pin goes high without delay.

The PORDEL register sets the delay for the POR flag pin. The POR delay time starts as soon as the AV_{IN} pin voltage rises above the system UVLO upper threshold set by the PORUP register. The POR output goes low without delay if AV_{IN} falls below the lower UVLO threshold set by the PORDN register.



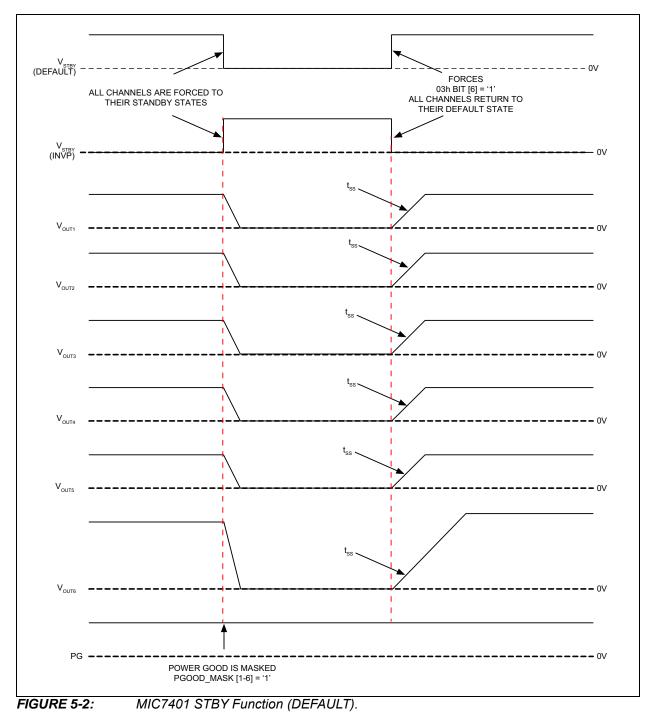


DS20005618A-page 32

5.2 Stand-by (STBY) Pin (Wake-Up)

An I²C write command to the STBY_CTRL_REG register or the STBY pin can be used to set the MIC7401 into standby mode. The standby (STBY) pin provides a hardware-specific manner in which to wake-up from stand-by mode and go into normal mode. Figure 5-2 shows the STBY pin operation. A low-to-high transition on the STBY pin switches the output from stand-by mode to normal mode.

There is a 100 μ s STBY deglitch time to eliminate nuisance tripping, then all the regulators are enabled at the same time and ramp up with their programmed ramp rates.



6.0 PCB LAYOUT GUIDELINES

PCB layout is critical to achieve reliable, stable, and efficient performance. A ground plane is required to control EMI and minimize the inductance in power, signal, and return paths.

To minimize EMI and output noise, follow these layout recommendations to ensure proper operation:

6.1 General

- Most of the heat removed from the IC is due to the exposed pad (EP) on the bottom of the IC conducting heat into the internal ground planes and the ground plane on the bottom side of the board. Use at least 16 vias for the EP to ground plane connection.
- Do not connect the PGND and AGND traces together on the top layer. The single point connection is made on the layer 2 ground plane.
- Do not put a via directly in front of a high current pin, SW, PGND, or PVIN. This will increase the trace resistance and parasitic inductance.
- Do not place a via in between the input and output capacitor ground connection. Put it to the inside of the output capacitor and in the way of the high di/dt current path.
- Route all power traces on the top layer.
- Place the input capacitors first and put them as close as possible to the IC.

6.2 IC

- The 2.2 μ F ceramic capacitor, which is connected to the AVIN pin, must be located right at the IC. The AVIN pin is very noise sensitive and placement of the capacitor is very critical. Use wide traces to connect to the AVIN and AGND pins.
- The analog ground pin (AGND) must be connected directly to the ground planes. Do not route the AGND pin to the PGND Pad on the top layer.
- Use wide traces to route the input and output power lines.
- Use Layer 5 as an input voltage power plane.
- Layer 2 and the bottom layer (Layer 6) are ground planes.

6.3 Input Capacitor

- A 10 µF X5R or X7R dielectrics ceramic capacitor is recommended on each of the PVIN pins for bypassing.
- Place the input capacitors on the same side of the board and as close to the IC as possible.
- Keep both the PVIN pin and PGND connections short.
- If possible, place vias to the ground plane close to the each input capacitor ground terminal, but not in the way of the high di/dit current path.
- Use either X7R or X5R dielectric input capacitors. Do not use Y5V or Z5U type capacitors.
- Do not replace the ceramic input capacitor with any other type of capacitor. Any type of capacitor can be placed in parallel with the input capacitor.
- In "Hot-Plug" applications, a Tantalum or Electrolytic bypass capacitor must be used to limit the overvoltage spike seen on the input supply with power is suddenly applied.

6.4 Inductor

- Keep the inductor connection to the switch node (SW) short.
- Do not route any digital lines underneath or close to the inductor.
- To minimize noise, place a ground plane underneath the inductor.

6.5 Output Capacitor

- Use a wide trace to connect the output capacitor ground terminal to the input capacitor ground terminal.
- The OUT[1-6] trace should be separate from the power trace and connected as close as possible to the output capacitor. Sensing a long high-current load trace can degrade the DC load regulation.

6.6 Proper Termination of Unused Pins

Many designs will not require all six DC/DC output voltages. In these cases, the unused pin must be connected to either VIN or GND. The schematic in Figure 6-1 shows where to tie the unused pins and Table 6-1 summarizes the connections.

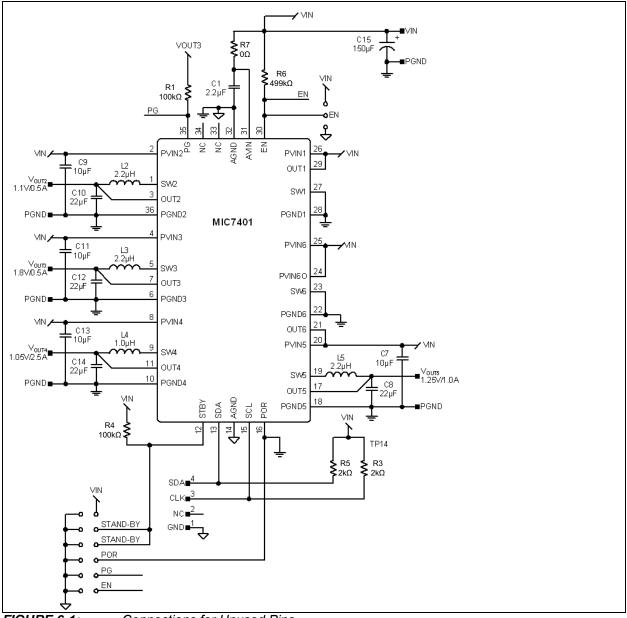


FIGURE 6-1: Co

Connections for Unused Pins.

TABLE 6-1: SUMMARIZATION OF UNUSED PIN CONNECTIONS

Unused	VIN	PGND
Boost	PVIN6, PGIN6O, VOUT6	PGND6, SW6
Buck	PVIN[x], VOUT[x}	PGND[6], SW[x]
POR		POR

^{© 2018} Microchip Technology Inc.

7.0 I²C CONTROL REGISTER

The MIC7401 I²C Read/Write registers are detailed here. During normal operation, the configuration data can be saved into non-volatile registers in EEPROM by addressing the chip and writing to SAVECONFIG key = 66'h. Saving CONFIG data to EEPROM takes time so the external host should poll the MIC7401 and read the CONFIG bit[1] of EEPROM Ready register 01'h to determine the end of programming.

All transactions start with a control byte sent from the I²C master device. The control byte begins with a START condition, followed by a 7-bit slave address. The slave address is seven bits long followed by an eighth bit which is a data direction bit (R/W), a "0" indicates a transmission (WRITE) and a "1" indicates a request for data (READ). A data transfer is always terminated by a STOP condition that is generated by the master.

7.1 Serial Port Operation

7.1.1 EXTERNAL HOST INTERFACE

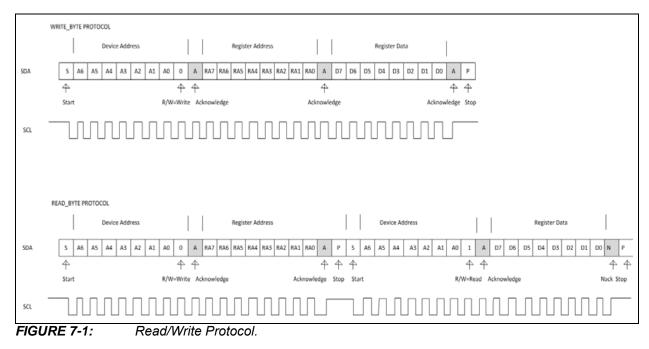
Bidirectional I²C port capable of Standard (up to 100 kbits/s), Fast (up to 400 kbits/s), Fast Plus (up to 1 Mbit/s) and High Speed (up to 3.4 Mbit/s) as defined in the I²C-Bus Specification.

The MIC7401 acts as an I^2C slave when addressed by the external host. The MIC7401 slave address uses a fixed 7-bit code and is followed by an R/W bit which is part of the control word that is right after the start bit as shown in Figure 7-1 in the Device Address column.

The MIC7401 can receive multiple data bytes after a single address byte and automatically increments its register pointer to block fill internal volatile memory. Byte data is latched after individual bytes are received so multi-byte transfers could be corrupted if interrupted mid-stream.

No system clock is required by the digital core for I^2C access from the external host (only the host SCL clock is assumed).

In order to prevent spurious operation of the I^2C , if a start bit is seen, then any partial communication is aborted and new I^2C data is allowed. Start bit is when SDA goes low when SCL is high. Stop bit is when SDA goes high when SCL is high. Normal I^2C exchange is shown in Figure 7-1.



7.1.2 SPECIAL HOST I²C COMMANDS

The following commands are all 2 byte communications:

- Byte1 = Device address with write bit set, LSB = 0.
- Byte2 = Special key.

Special keys include the following:

- SAVECONFIG Key = 66'h. Saves the shadow register configuration data into EEPROM registers 03'h through 23'h.
- RESET Key = 6A'h. Reloads only NORMAL mode voltage and current limit settings then enables the regulator to NORMAL mode with no soft-start, no sequencing, and no delays. Then it clears the STANDBY register bit 6 in register 03'h.
- RELOAD Key = 6B'h. Reloads all data from EEPROM into the shadow registers. No other actions are performed, including soft-start, sequencing, and delay.
- REBOOT Key = 6C'h. Turns all regulators OFF, reloads EEPROM data into shadow registers, then re-sequences the regulators with the programmed soft-start and sequence delays.
- SEQUENCE Key = 6D'h. Turns all regulators OFF, restarts the sequencer including soft-start and sequence delays.

^{© 2018} Microchip Technology Inc.

8.0 REGISTER SETTINGS DESCRIPTIONS

8.1 Power Good Register (00'h)

This register indicates when the regulators 1 - 6 output voltage is above 91% of the target value. The MIC7400 deglitches the input signal for 50 µs in order to prevent false events. The global PG pin indicator is functional 'AND' of all the power good indicators during sequencing. Once the power-up sequence is complete, the global power good output stays high unless an output falls below its power-good limit, a thermal fault occurs, the input voltage drops below the lower UVLO threshold or an output is turned OFF by setting the enable register bit to "0" if the PGOOD_MASK[x] bit is set to "0".

Register Name	PGOOD1-6_REG		gister Name PGOOD1-6_REG		Power Good S	Status Register
Address		_		0x0)0'h	
Field	Bit	R/W	Default	Descr	iption	
PGOOD1	0	R	0	Power Good indica	ator for Regulator 1	
PGOODT	0	ĸ	0	0 = Buck Not Valid	1 = Buck Valid	
PGOOD2	1	R	0	Power Good indica	ator for Regulator 2	
PGOODZ	I	ĸ	0	0 = Buck Not Valid	1 = Buck Valid	
PGOOD3	2	R	0	Power Good indica	ator for Regulator 3	
FGOOD3		ĸ	0	0 = Buck Not Valid	1 = Buck Valid	
PGOOD4	3	R	0	Power Good indica	ator for Regulator 4	
FGOOD4	3	ĸ	0	0 = Buck Not Valid	1 = Buck Valid	
PGOOD5	4	Р	0	Power Good indica	ator for Regulator 5	
PGOOD5	4	R	0	0 = Buck Not Valid	1 = Buck Valid	
PGOOD6	5 R	F		0	Power Good indica	ator for Regulator 6
FGOOD6		R	0	0 = Boost Not Valid	1 = Boost Valid	
Reserved	6	R/W	0	Not Used	—	
Reserved	7	R/W	0	Not Used	_	

TABLE 8-1:POWER GOOD STATUS REGISTER

8.2 EEPROM-Ready Register (01'h)

This register indicates the status of EEPROM to external I²C host.

The READY bit = 1 when the Trim and Configuration data have been loaded into core from EEPROM after reset, reboot or reload and the chip is ready for operation. If the SAVE1 bit in register 04'h is read in as logic 1, the configuration registers will not be loaded from the EEPROM memory and the READY bit will still get set indicating that any startup procedure involving the EEPROM memory is complete. The READY bit will be set to 1 after loading or attempting to load Trim and Configuration data from EEPROM into volatile memory. The Trim data will always be loaded and if SAVE1 bit in register 04'h is set to logic 0, Configuration data is also loaded. Regardless of the SAVE1 bit being set or not, after the loading operation the READY bit is set to 1.

The CONFIG bit = 1 when the Configuration data has been saved to EEPROM after the SAVECONFIG Code is issued from the Host. If CONFIG=1 before the SAVECONFIG code is issued, CONFIG will be cleared immediately and then will be set to logic 1 again once all Configuration data is written to the EEPROM memory.

The CALIB bit = 1 when the Trim data have been saved to EEPROM after the SAVETRIM Code is issued from the Host. If CALIB = 1 before the SAVETRIM code is issued, CALIB will be cleared immediately and then will be set to logic 1 again once all Trim data is written to the EEPROM memory.

The EEPREAD and EEPWRITE bits indicate if an EEPROM read or write fault has occurred. These bits should be read and cleared prior to reloading data from the EEPROM memory.

Register Name	STATUS_REG			EEPROM Sta	atus Register	
Address		—		0x01'h		
Field	Bit	R/W	Default	Descr	iption	
READY	0 R 0 Indicate ready for operation when the trim and config		•			
				0 = Data not loaded	1 = Chip ready	
CONFIG	1	1 R 0 Indicate Configurat		on saved to EEPROM		
CONFIG		ĸ	0	0 = Configuration not saved	1 = Configuration saved	
CALIB	2	R	0	Indicate trim data has b	een saved to EEPROM	
CALIB	Z	ĸ		0 = Trim not saved	1 = Trim saved	
Reserved	3	R/W	0	Not Used		
Reserved	4	R/W	0	Not Used	—	
Reserved	5	R/W	0	Not Used		
EEPREAD	6	R/W	0	EEPRO	M Read	
LEFREAD	0	K/VV	U	0 = No Fault	1 = Fault	
	7	7 R/W	0	EEPRO	M Write	
EEPWRITE	1			0 = No Fault	1 = Fault	

TABLE 8-2: EI	EPROM STATUS REGISTER
---------------	-----------------------

8.3 Fault Registers (02'h)

This register indicates the overcurrent flag for each regulator and one global overtemperature (OT). These register bits are set by an overcurrent condition and reset by writing a logic "0" to each bit by the I²C host. The respective channel must be restarted to enter normal functionality in order to successfully clear the over current fault.

If the fault condition persists, the bit will be set to logic "1" again immediately by the MIC7401 after it is written to logic "0" by the host.

Register Name	FAULT_REG			Overcurrent Stat	us Fault Register		
Address		_	— 0x02'h		2'h		
Field	Bit	R/W	Default	Descr	iption		
REG10C	0	R/W	0	Regulator 1	Overcurrent		
REGIOC	0	r///	0	0 = No Fault	1 = Fault		
REG2OC	1	R/W	0	Regulator 2	Overcurrent		
REG2OC	I	R/W	0	0 = No Fault	1 = Fault		
REG3OC	2	R/W	0	Regulator 3	Overcurrent		
REGSOC	2	R/W	0	0 = No Fault	1 = Fault		
REG4OC	3	R/W	0	Regulator 4	Overcurrent		
REG40C	3	R/W		0 = No Fault	1 = Fault		
REG5OC	4				_	Regulator 5	Overcurrent
REGOUC	4	R/W	0	0 = No Fault	1 = Fault		
REG6OC	5		0	Regulator 6	Overcurrent		
REGOUC	5	R/W	0	0 = No Fault	1 = Fault		
Reserved	6	R/W	0	Reserved			
ОТ	7	R/W	0	Overtem	perature		
	1	FV/ VV	0	0 = No Fault	1 = Fault		

 TABLE 8-3:
 OVERCURRENT STATUS FAULT REGISTER

8.4 Standby Register (03'h)

This register controls standby mode operation. Global standby mode can either be enabled by l^2C or by changing the logic state of the STBY input pin. Global standby is controlled by the STBY_MODEB bit. When STBY_MODEB [6] = 1 then the regulators output voltages are set to their normal mode output voltage settings, (05'h - 0A'h) registers. When STBY_MODEB [6] = 0 then regulators output voltages are set to the standby mode output voltage settings, (0B'h - 10'h) registers. If STBY [1-6] register is set to logic "0", then the output is shut off in standby mode.

The global power good flag is asserted when an output is disabled unless the power good mask bit (PGOOD_MASK[x]) is set to 1.

Register Name	STBY_CTRL_REG		IRL_REG Standby Register		Register	
Address		—		0x0	3'h	
Field	Bit	R/W	Default	Descr	iption	
OTDV4	0	R/W	1	Regulator 1 Stand	by Voltage Control	
STBY1	0	R/W		0 = OFF	1 = ON	
STBY2	1	R/W	1	Regulator 2 Stand	by Voltage Control	
51612	I	R/W		0 = OFF	1 = ON	
	2	R/W	1	Regulator 3 Stand	by Voltage Control	
51813	STBY3 2	R/W		0 = OFF	1 = ON	
		3 R/W	1	Regulator 4 Stand	by Voltage Control	
STBY4	3			0 = OFF	1 = ON	
STBY5	4		1	Regulator 5 Stand	by Voltage Control	
51615	4	R/W		0 = OFF	1 = ON	
	F		4	Regulator 6 Stand	by Voltage Control	
STBY6	5	5 R/W	1	0 = OFF	1 = ON	
				Global Stan	dby Control	
STBY_MODEB	6	R/W	1	0 = All regulators in Standby Mode	1 = All regulators in Normal Mode	
Reserved	7	R/W	0	Not used		

TABLE 8-4:STANDBY REGISTER

8.5 Enable/Disable Register (04'h)

This register controls the enable/disable of each DC/DC regulators. When EN(n) bit transitions from "0" to "1", then the regulator(n) is enabled with soft-start unless the STBY_MODEB register bit in register 03'h is set to logic "0".

The configuration save bit "SAVE1" should be cleared by customer before saving configuration data to EEPROM. This bit is used during power up to indicate via the Status register (00'h) that configuration data has previously been stored.

Register Name	EN_REG			Enable	Register
Address		_		0x0)4'h
Field	Bit R/W Default		Default	Desci	iption
EN1	0	0 R/W	1	Regulator 1 ON	/OFF Control bit
	0			0 = OFF	1 = ON
EN2	1	R/W 1		Regulator 2 ON	/OFF Control bit
EINZ	I	R/W	I	0 = OFF	1 = ON
EN3	2	R/W	1	Regulator 3 O	N/OFF Control
EINS	2	R/W		0 = OFF	1 = ON
ENA	2	3 R/W	1	Regulator 4 O	N/OFF Control
EN4	3			0 = OFF	1 = ON

TABLE 8-5: ENABLE REGISTER

Register Name	EN_REG			Enable Register			
Address	—			0x0	0x04'h		
Field	Bit R/W Default		Default	Description			
EN5	4	R/W	1	Regulator 5 ON/OFF Control			
END	4	F(/ VV	I	0 = OFF	1 = ON		
EN6	5	R/W	1	Regulator 6 ON/OFF Control			
LINO	5			0 = OFF	1 = ON		
Reserved	6	R/W	0	Not Used	_		
				Save Con	figuration		
SAVE1	7	R/W	0	0 = Configuration not saved to EEPROM	1 = Configuration saved to EEPROM		

TABLE 8-5: ENABLE REGISTER (CONTINUED)

8.6 Regulator Output Voltage Setting NORMAL Mode (05'h – 09'h)

One register for each regulator output (OUT1 – OUT5). Sets output voltage of regulator for NORMAL mode operation.

Register Name	OUT1-5_REG				DVC Register	s for OUT[1-5]	
Address			_	OUT1 =		= 0x06'h; OUT3 = ; OUT5 = 0x09'h	= 0x07'h
Field	Bit	R/W	Default		Descr	ription	
OUT[1-5]	5:0	R/W	OUT1 = 011110 (1.8V) OUT2 = 101100 (1.1V) OUT3 = 011110 (1.8V) OUT4 = 101101 (1.05V) OUT5 = 101001 (1.25V)	DV 000000 = 3.30V 000001 = 3.25V 000010 = 3.20V 000010 = 3.10V 000100 = 3.10V 000101 = 3.05V 000110 = 3.00V 000110 = 3.00V 000111 = 2.95V 001001 = 2.80V 001011 = 2.80V 001101 = 2.65V 001101 = 2.60V	C from 3.3V to 0 010000 = 2.50V 010001 = 2.45V 010010 = 2.40V 010011 = 2.35V 010100 = 2.30V 010100 = 2.30V 010101 = 2.25V 010110 = 2.20V 010111 = 2.5V 011001 = 2.00V 011001 = 2.00V 011011 = 1.95V 011101 = 1.85V 011110 = 1.80V	etting of OUT[1-5 .8V in -50 mV sta 100000 = 1.70V 10001 = 1.65V 100010 = 1.60V 100011 = 1.55V 100100 = 1.50V 100101 = 1.45V 100110 = 1.45V 101001 = 1.45V 101001 = 1.25V 101001 = 1.25V 101011 = 1.25V 101101 = 1.05V 101110 = 1.00V	eps 110000 = 0.90V 110001 = 0.85V 110010 = 0.80V 110011 = 0.80V 110100 = 0.80V 110100 = 0.80V 110111 = 0.80V 110111 = 0.80V 111001 = 0.80V 111011 = 0.80V 111101 = 0.80V 111101 = 0.80V 111101 = 0.80V
	6		0	001111 = 2.55V Not	011111 = 1.75V Used	101111 = 0.95V _	111111 = 0.80V
_	7	_	0	Not	Used	_	_

TABLE 8-6: DVC REGISTERS FOR OUT[1 – 5]

© 2018 Microchip Technology Inc.

8.7 Boost Regulator Output Voltage Setting NORMAL Mode (0A'h)

Sets output voltage of the boost regulator (OUT6) in NORMAL mode operation.

Register Name		OUT6_REG			DVC Re	gisters	
Address		_			0x0	A'h	
Field	Bit	R/W	Default		Descr	iption	
				DVC	from 14V to 7V i	n 200 mV decren	nents
				000000 = 14.0V	010000 = 10.8V	100000 = 7.6V	110000 = 7.0V
				000001 = 13.8V	010001 = 10.6V	100001 = 7.4V	110001 = 7.0V
				000010 = 13.6V	010010 = 10.4V	100010 = 7.2V	110010 = 7.0V
				000011 = 13.4V	010011 = 10.2V	100011 = 7.0V	110011 = 7.0V
		R/W	001010 (12V)	000100 = 13.2V	010100 = 10.0V	100100 = 7.0V	110100 = 7.0V
				000101 = 13.0V	010101 = 9.8V	100101 = 7.0V	110101 = 7.0V
				000110 = 12.8V	010110 = 9.6V	100110 = 7.0V	110110 = 7.0V
OUT6	5:0			000111 = 12.6V	010111 = 9.4V	100111 = 7.0V	110111 = 7.0V
			(,	001000 = 12.4V	011000 = 9.2V	101000 = 7.0V	111000 = 7.0V
				001001 = 12.2V	011001 = 9.0V	101001 = 7.0V	111001 = 7.0V
				001010 = 12.0V	011010 = 8.8V	101010 = 7.0V	111010 = 7.0V
				001011 = 11.8V	011011 = 8.6V	101011 = 7.0V	111011 = 7.0V
				001100 = 11.6V	011100 = 8.4V	101100 = 7.0V	111100 = 7.0V
				001101 = 11.4V	011101 = 8.2V	101101 = 7.0V	111101 = 7.0V
				001110 = 11.2V	011110 = 8.0V	101110 = 7.0V	111110 = 7.0V
				001111 = 11.0V	011111 = 7.8V	101111 = 7.0V	111111 = 7.0V
—	6		0	Not	Used	-	_
—	7	_	0	Not	Used	-	_

TABLE 8-7: DVC REGISTERS FOR OUT6

8.8 Regulator Voltage Setting STBY Mode (0B'h – 0F'h)

This register is used to sets the output voltage of regulators 1 - 5 in STBY mode operation.

Register Name		STBY_O	UT1-5_REG		Standby DV	C Registers	
Address			_	OUT1 =	0x0B'h; OUT2 = OUT4 = 0x0E'h;	0x0C'h; OUT3 = OUT5 = 0x0F'h	
Field	Bit	R/W	Default		Descr	iption	
					Output Voltage se 'C from 3.3V to 0		
				000000 = 3.30V	010000 = 2.50V	100000 = 1.70V	110000 = 0.90V
				000001 = 3.25V	010001 = 2.45V	100001 = 1.65V	110001 = 0.85V
			OUT1 = 011110 (1.8V) OUT2 = 101100 (1.1V) OUT3 = 011110 (1.8V) OUT4 = 101101 (1.05V) OUT5 = 101001	000010 = 3.20V	010010 = 2.40V	100010 = 1.60V	110010 = 0.80V
				000011 = 3.15V	010011 = 2.35V	100011 = 1.55V	110011 = 0.80V
				000100 = 3.10V	010100 = 2.30V	100100 = 1.50V	110100 = 0.80V
		5:0 R/W		000101 = 3.05V	010101 = 2.25V	100101 = 1.45V	110101 = 0.80V
SB_OUT	5.0			000110 = 3.00V	010110 = 2.20V	100110 = 1.40V	110110 = 0.80V
[1-5]	5.0			000111 = 2.95V	010111 = 2.15V	100111 = 1.35V	110111 = 0.80V
				001000 = 2.90V	011000 = 2.10V	101000 = 1.30V	111000 = 0.80V
				001001 = 2.85V	011001 = 2.05V	101001 = 1.25V	111001 = 0.80V
			(1.25V)	001010 = 2.80V	011010 = 2.00V	101010 = 1.20V	111010 = 0.80V
				001011 = 2.75V	011011 = 1.95V	101011 = 1.15V	111011 = 0.80V
				001100 = 2.70V	011100 = 1.90V	101100 = 1.10V	111100 = 0.80V
				001101 = 2.65V	011101 = 1.85V	101101 = 1.05V	111101 = 0.80V
				001110 = 2.60V	011110 = 1.80V	101110 = 1.00V	111110 = 0.80V
				001111 = 2.55V	011111 = 1.75V	101111 = 0.95V	111111 = 0.80V
—	6	—	0	Not I	Used	-	_
_	7	_	0	Not I	Used	-	_

TABLE 8-8: STANDBY REGISTERS

8.9 Boost Regulator Output Voltage Setting STBY Mode (10'h)

Sets output voltage of the boost regulator (OUT6) for STBY mode operation.

Register Name	STBY_OUT6_REG			DVC Re	egisters		
Address		_			0x1	0'h	
Field	Bit	R/W	Default		Descr	iption	
				DVC	from 14V to 7V i	n 200 mV decren	nents
				000000 = 14.0V	010000 = 10.8V	100000 = 7.6V	110000 = 7.0V
				000001 = 13.8V	010001 = 10.6V	100001 = 7.4V	110001 = 7.0V
				000010 = 13.6V	010010 = 10.4V	100010 = 7.2V	110010 = 7.0V
		R/W		000011 = 13.4V	010011 = 10.2V	100011 = 7.0V	110011 = 7.0V
			001010 (12V)	000100 = 13.2V	010100 = 10.0V	100100 = 7.0V	110100 = 7.0V
	5:0			000101 = 13.0V	010101 = 9.8V	100101 = 7.0V	110101 = 7.0V
				000110 = 12.8V	010110 = 9.6V	100110 = 7.0V	110110 = 7.0V
SB_OUT6				000111 = 12.6V	010111 = 9.4V	100111 = 7.0V	110111 = 7.0V
				001000 = 12.4V	011000 = 9.2V	101000 = 7.0V	111000 = 7.0V
				001001 = 12.2V	011001 = 9.0V	101001 = 7.0V	111001 = 7.0V
				001010 = 12.0V	011010 = 8.8V	101010 = 7.0V	111010 = 7.0V
				001011 = 11.8V	011011 = 8.6V	101011 = 7.0V	111011 = 7.0V
				001100 = 11.6V	011100 = 8.4V	101100 = 7.0V	111100 = 7.0V
				001101 = 11.4V	011101 = 8.2V	101101 = 7.0V	111101 = 7.0V
				001110 = 11.2V	011110 = 8.0V	101110 = 7.0V	111110 = 7.0V
				001111 = 11.0V	011111 = 7.8V	101111 = 7.0V	111111 = 7.0V
—	6	—	0	Not I	Jsed		_
_	7	—	0	Not I	Jsed	_	

TABLE 8-9:STANDBY DVC REGISTER FOR OUT6

8.10 Sequence Register (11'h)

Each regulator can be assigned to start in any one of six sequencing slots (1 to 6). If starting in slot 1, the regulator starts immediately. If starting in any other slot, the regulator must wait for the PGOOD = 1 flags of all regulators assigned to the preceding slot and then wait for the specified delay time (register 17'h) i.e., all PGOODs in preceding state flag then the delay timer is started and when delay completes the regulator is enabled.

Each regulator will delay its startup (after the appropriate preceding PGOOD flags) by the delay set in the Delay Register (17'h), unless the regulator is assigned to sequence state 0.

If all default Enable bits = 0 the IC starts up, but no outputs are enabled.

Sequencing is only used during initial startup, and not used when outputs are enabled via I²C command. If outputs are enabled via I²C, then soft-start is still active, but start-up delays (timed from preceding PGOODs) are not.

TABLE 8-10:	SEQUENCE STATE 1 REGISTER
-------------	---------------------------

Register Name	SEQ1_REG			Sequence	e Register
Address	_			0x1	1'h
Field	Bit R/W Default		Default	Description	
REG1SQ1	0	R/W	0	0 = No Start	1 = Regulator 1 will Start in Sequence State 1
REG2SQ1	1	R/W	0	0 = No Start	1 = Regulator 2 will Start in Sequence State 1
REG3SQ1	2	R/W	0	0 = No Start	1 = Regulator 3 will Start in Sequence State 1

Register Name	SEQ1_REG			Sequenc	e Register
Address		—		0x	11'h
Field	Bit R/W Default		ield Bit R/W Default Description		ription
REG4SQ1	3	R/W	1	0 = No Start	1 = Regulator 4 will Start in Sequence State 1
REG5SQ1	4	R/W	0	0 = No Start	1 = Regulator 5 will Start in Sequence State 1
REG6SQ1	5	R/W	0	0 = No Start	1 = Regulator 6 will Start in Sequence State 1
	6	R/W	0	Reserved	
—	7	R/W	0	Res	erved

TABLE 8-10: SEQUENCE STATE 1 REGISTER (CONTINUED)

TABLE 8-11: SEQUENCE STATE 2 REGISTER

Register Name	SEQ2_REG		3	Sequenc	e Register
Address		_		0x	12'h
Field	Bit	R/W	Default	Desc	ription
REG1SQ2	0	R/W	0	0 = No Start	1 = Regulator 1 will Start in Sequence State 2
REG2SQ2	1	R/W	1	0 = No Start	1 = Regulator 2 will Start in Sequence State 2
REG3SQ2	2	R/W	1	0 = No Start	1 = Regulator 3 will Start in Sequence State 2
REG4SQ2	3	R/W	0	0 = No Start	1 = Regulator 4 will Start in Sequence State 2
REG5SQ2	4	R/W	0	0 = No Start	1 = Regulator 5 will Start in Sequence State 2
REG6SQ2	5	R/W	0	0 = No Start	1 = Regulator 6 will Start in Sequence State 2
—	6	R/W	0	Reserved	
—	7	R/W	0	Res	erved

TABLE 8-12: SEQUENCE STATE 3 REGISTER

Register Name	SEQ3_REG		3	Sequence Register	
Address		_		0x13'h	
Field	Bit	R/W	Default	Desc	ription
REG1SQ3	0	R/W	1	0 = No Start	1 = Regulator 1 will Start in Sequence State 3
REG2SQ3	1	R/W	0	0 = No Start	1 = Regulator 2 will Start in Sequence State 3
REG3SQ3	2	R/W	0	0 = No Start	1 = Regulator 3 will Start in Sequence State 3
REG4SQ3	3	R/W	0	0 = No Start	1 = Regulator 4 will Start in Sequence State 3
REG5SQ3	4	R/W	0	0 = No Start	1 = Regulator 5 will Start in Sequence State 3
REG6SQ3	5	R/W	0	0 = No Start	1 = Regulator 6 will Start in Sequence State 3

© 2018 Microchip Technology Inc.

TABLE 8-12: SEQUENCE STATE 3 REGISTER (CONTINUED)

Register Name	SEQ3_REG			Sequence Register
Address	_			0x13'h
Field	Bit	Bit R/W Default		Description
	6	R/W	0	Reserved
	7	R/W	0	Reserved

TABLE 8-13: SEQUENCE STATE 4 REGISTER

Register Name	SEQ4_REG		3	Sequenc	e Register
Address		—		0x14'h	
Field	Bit	R/W	Default	Desc	ription
REG1SQ4	0	R/W	0	0 = No Start	1 = Regulator 1 will Start in Sequence State 4
REG2SQ4	1	R/W	0	0 = No Start	1 = Regulator 2 will Start in Sequence State 4
REG3SQ4	2	R/W	0	0 = No Start	1 = Regulator 3 will Start in Sequence State 4
REG4SQ4	3	R/W	0	0 = No Start	1 = Regulator 4 will Start in Sequence State 4
REG5SQ4	4	R/W	1	0 = No Start	1 = Regulator 5 will Start in Sequence State 4
REG6SQ4	5	R/W	0	0 = No Start	1 = Regulator 6 will Start in Sequence State 4
	6	R/W	0	Reserved	
—	7	R/W	0	Res	erved

TABLE 8-14: SEQUENCE STATE 5 REGISTER

Register Name	SEQ5_REG			Sequence	e Register
Address		_		0x1	5'h
Field	Bit	R/W	Default	Descr	iption
REG1SQ5	0	R/W	0	0 = No Start	1 = Regulator 1 will Start in Sequence State 5
REG2SQ5	1	R/W	0	0 = No Start	1 = Regulator 2 will Start in Sequence State 5
REG3SQ5	2	R/W	0	0 = No Start	1 = Regulator 3 will Start in Sequence State 5
REG4SQ5	3	R/W	0	0 = No Start	1 = Regulator 4 will Start in Sequence State 5
REG5SQ5	4	R/W	0	0 = No Start	1 = Regulator 5 will Start in Sequence State 5
REG6SQ5	5	R/W	0	0 = No Start	1 = Regulator 6 will Start in Sequence State 5
—	6	R/W	0	Reserved	
	7	R/W	0	Rese	erved

Register Name	SEQ6_REG			Sequence	e Register
Address		_		0 x1	6'h
Field	Bit	R/W	Default	Description	
REG1SQ6	0	R/W	0	0 = No Start	1 = Regulator 1 will Start in Sequence State 6
REG2SQ6	1	R/W	0	0 = No Start	1 = Regulator 2 will Start in Sequence State 6
REG3SQ6	2	R/W	0	0 = No Start	1 = Regulator 3 will Start in Sequence State 6
REG4SQ6	3	R/W	0	0 = No Start	1 = Regulator 4 will Start in Sequence State 6
REG5SQ6	4	R/W	0	0 = No Start	1 = Regulator 5 will Start in Sequence State 6
REG6SQ6	5	R/W	1	0 = No Start	1 = Regulator 6 will Start in Sequence State 6
—	6	R/W	0	Reserved	
—	7	R/W	0	Reserved	

TABLE 8-15: SEQUENCE STATE 6 REGISTER

8.11 Delay Register (17'h)

The STDEL register sets the delay between powering up of each regulator at initial power up (see Figure 5-1). Once all the internal power good registers PGOOD[1-6] are all "1", then the global PG pin goes high without delay.

The PORDEL register sets the delay for the POR flag pin. The POR delay time starts as soon as AVIN pin voltage rises above the system UVLO upper threshold set by the PORUP register (21'h). The POR output goes low without delay if AVIN falls below the lower UVLO threshold set by the PORDN register (22'h).

Register Name	DELAY_CNTL_REG			Delay Register			
Address		_			0 x1	17'h	
Field	Bit	R/W	Default		Descr	ription	
			004	Delay T	ime from 0 ms to	o 7 ms in 1 ms ind	crement
STDEL	2:0	R/W	001 (1 ms)	000 = 0 ms	010 = 2 ms	100 = 4 ms	110 = 6 ms
			(1115)	001 = 1 ms	011 = 3 ms	101 = 5 ms	111 = 7 ms
		R/W	00011 (20 ms)	Delay Time from 5 ms to 160 ms in 5 ms increment			
				00000 = 5ms	01000 = 45ms	10000 = 85ms	11000 = 125ms
				00001 = 10ms	01001 = 50ms	10001 = 90ms	11001 = 130ms
				00010 = 15ms	01010 = 55ms	10010 = 95ms	11010 = 135ms
PORDEL	7:3			00011 = 20ms	01011 = 60ms	10011 = 100ms	11011 = 140ms
			(20113)	00100 = 25ms	01100 = 65ms	10100 = 105ms	11100 = 145ms
			-	00101 = 30ms	01101 = 70ms	10101 = 110ms	11101 = 150ms
				00110 = 35ms	01110 = 75ms	10110 = 115ms	11110 = 155ms
				00111 = 40ms	01111 = 80ms	10111 = 120ms	11111 = 160ms

TABLE 8-16: DELAY REGISTER

8.12 Soft-Start Registers (18'h – 1A'h)

When regulator(n) is turned on from either the Enable Register (04'h) in NORMAL mode or from the Standby Register (03'h) in STANDBY mode, the three REG(n)SS soft-start bits are used to control both the rising and falling ramp rate of the outputs.

In NORMAL mode, the outputs are stepped from the current regulator voltage settings to a newly programmed regulator voltage setting or to the default value.

On power-up, the regulator voltage output is set to the lowest possible voltage setting, which is 3F'h. The voltage regulator will change by one step or increment at a time. The amount of time between each step is controlled by the soft-start registers. Table 8-17 details the amount of time for each encoded soft-start value.

TABLE 8-17: SOFT-START REGISTER SPEED SETTINGS							
Register	R/W	Default	Description				
	S_SPEED = 0 R/W	000	Soft-Start Time from 4 µs to 512 µs				s
SS_SPEED = 0			000 = 4 µs	010 = 16 µs	100 = 64 µs	110 = 256 µs	
			001 = 8 µs	011 = 32 µs	101 = 128 µs	111 = 512 µs	
		000	S	oft-Start Time fro	om 8 µs to 1024 µ	ıs	
SS_SPEED = 1	R/W		000 = 8 µs	010 = 32 µs	100 = 128 µs	110 = 512 µs	
			001 = 16 µs	011 = 64 µs	101 = 256 µs	111 = 1024 μs	

TABLE 8-17: SOFT-START REGISTER SPEED SETTINGS

Register Name	SS1-2_REG		3	Soft-Start Register for V_{OUT1} and V_{OUT2}		
Address	—		_			0x18'h
Field	Bit	R/W	Default	Description		
REG1SS	2:0	R/W	001 (8 μs)	OUT1 Soft-Start Time. See Table 8-17 for Soft-Start settings.		
REG2SS	5:3	R/W	001 (8 μs)	OUT2 Soft-Start Time. See Table 8-17 for Soft-Start settings.		
_	6	R/W	0	Reserved		
SS_SPEED	7	R/W	0	Sets the speed of the clock to slow or fast for different clock divi- sion, see Table 8-17. 0 = Slow speed; 1 = Fast speed.		

TABLE 8-19: SOFT-START REGISTER OUT3 AND OUT4

Register Name	\$	683-4_REC	3	Soft-Start Register for V_{OUT3} and V_{OUT4}		
Address		—		0x19'h		
Field	Bit	R/W	Default	Description		
REG3SS	2:0	R/W	001 (8 μs)	OUT3 Soft-Start Time. See Table 8-17 for Soft-Start settings.		
REG4SS	5:3	R/W	001 (8 μs)	OUT4 Soft-Start Time. See Table 8-17 for Soft-Start settings.		
	6	R/W	0	Reserved		
	7	R/W	0	Reserved		

Register Name	5	685-6_REC	3	Soft-Start Register for V_{OUT5} and V_{OUT6}		
Address	_			0x1A'h		
Field	Bit	R/W	Default	Description		
REG5SS	2:0	2:0 R/W 001 (8 μs)		OUT5 Soft-Start Time. See Table 8-17 for Soft-Start settings.		
REG6SS	5:3	R/W	010 (16 μs)	OUT6 Soft-Start Time. See Table 8-17 for Soft-Start settings.		
—	6	R/W	0	Reserved		
—	7	R/W	0	Reserved		

TABLE 8-20: SOFT-START REGISTER OUT5 AND OUT6

8.13 Current-Limit (Normal Mode) Registers (1B'h – 1D'h)

This register is used to set the current limit for each DC/DC regulator in normal mode operation.

Register Name	ILI	MIT_1-2_R	EG	Curre	nt-Limit Registe	er for V _{OUT1} and	V _{OUT2}
Address		—			0x1	B'h	
Field	Bit	R/W	Default		Descr	ription	
				Normal current-limit for regulator 1 from 8.6A to 1.1A in 0.5A dec- rements			
	3:0	R/W	1001 (4.1A)	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A
REG1CL				0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A
				Normal current-	•	⁻ 2 from 8.6A to 1 ents	.1A in 0.5A dec-
DEODO	7.4	D 44/	1001	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A
REG2CL	7:4	R/W	(4.1A)	0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A

TABLE 8-21: CURRENT-LIMIT REGISTER IOUT1 AND IOUT2

TABLE 8-22: CURRENT-LIMIT REGISTER IOUT3 AND IOUT4

Register Name	ILI	MIT_3-4_R	EG	Current-Limit Register for V_{OUT3} and V_{OUT4}				
Address		—			0x1C'h			
Field	Bit	R/W	Default		Descr	iption		
				Normal current-limit for regulator 3 from 8.6A to 1.1A in 0.5A dec- rements				
		D 444	1001 (4.1A)	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A	
REG3CL	3:0 R/W	R/W		0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A	
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A	
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A	
				Normal current-limit for regulator 4 from 8.6A to 1.1A in 0.5A dec-				
					rem	ents		
550.00		D 444	0101	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A	
REG4CL	7:4	R/W	(6.1A)	0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A	
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A	
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A	

© 2018 Microchip Technology Inc.

Register Name	Name ILIMIT_5-6_REG Current-Limit Register for V _{OUT5} and V _{OUT6}			V _{OUT6}				
Address		—		0x1D'h				
Field	Bit	R/W	Default		Descr	iption		
		Normal current-limit for regulator 5 from 8.6A to 1.1A in 0.5/ rements					.1A in 0.5A dec-	
DEOLO			1001	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A	
REG5CL	3:0	R/W	(4.1A)	0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A	
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A	
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A	
			011	Current-li	mit from 2.6A to	1.78A in 0.12A de	ecrements	
REG6CL	6:4	R/W	011 (2.24A)	000 = 2.6A	010 = 2.36A	100 = 2.12A	110 = 1.88A	
		(2.277)	001 = 2.48A	011 = 2.24A	101 = 2.00A	111 = 1.76A		
	7	R/W	0	0 = Currer	nt-Limit On	1 = Currer	nt-Limit Off	

TABLE 8-23: CURRENT-LIMIT REGISTER IOUT5 AND IOUT6

8.14 Current-Limit (STBY Mode) Registers (1E'h – 20'h)

This register is used to set the current-limit for each DC/DC regulator when in standby (STBY) mode operation.

TABLE 8-24: STANDBY CURRENT-LIMIT REGISTER IOUT1 AND IOUT2

Register Name	STBY_	_ILIMIT_1-	2_REG	Standby C	urrent-Limit Re	gister for V _{OUT1}	and V _{OUT2}
Address		—			0x1E'h		
Field	Bit	R/W	Default		Descr	ription	
				Standby current-limit for regulator 1 from 8.6A to 1.1A in 0.5A dec- rements			
0540		5.44	1001	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A
SB1CL	3:0	R/W	W (4.1A)	0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A
				Standby current	-limit for regulato	or 2 from 8.6A to 1	1.1A in 0.5A dec-
					rem	ents	
0000		5.44	1001	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A
SB2CL	7:4	R/W	(4.1A)	0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A

TABLE 8-25: STANDBY CURRENT-LIMIT REGISTER IOUT3 AND IOUT4

Register Name	STBY_	ILIMIT_3-	4_REG	Standby C	Standby Current-Limit Register for $V_{\mbox{OUT3}}$ and $V_{\mbox{OUT4}}$		
Address		—			0x1F'h		
Field	Bit	R/W	Default	Description			
			1001 (4.1A)	Standby current-limit for regulator 3 from 8.6A to 1.1A in 0.5A decrements			
		5.44		0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A
SB3CL	3:0	R/W		0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A

Register Name	STBY_	_ILIMIT_3-	4_REG	Standby C	Standby Current-Limit Register for V_{OUT3} and V_{OUT4}				
Address		— 0x1F'h							
Field	Bit	R/W	Default	Description					
				Standby curre	•	ator 4 from 8.6A t ments	o 1.1A in 0.5A		
	7:4	R/W	0101 (6.1A)	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A		
SB4CL				0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A		
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A		
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A		

TABLE 8-25: STANDBY CURRENT-LIMIT REGISTER I_{OUT3} AND I_{OUT4} (CONTINUED)

TABLE 8-26: STANDBY CURRENT-LIMIT REGISTER IOUT5 AND IOUT6

Register Name	STBY_	ILIMIT_5-	6_REG	Standby C	Standby Current-Limit Register for V_{OUT5} and V_{OUT6}				
Address		—			0x20'h				
Field	Bit	R/W	Default		Descr	ription			
				Standby current	Standby current-limit for regulator 5 from 8.6A to 1.1A in 0.5A dec- rements				
00501	3:0	R/W	1001 (4.1A)	0000 = 8.6A	0100 = 6.6A	1000 = 4.6A	1100 = 2.6 A		
SB5CL				0001 = 8.1A	0101 = 6.1A	1001 = 4.1A	1101 = 2.1A		
				0010 = 7.6A	0110 = 5.6A	1010 = 3.6A	1110 = 1.6A		
				0011 = 7.1A	0111 = 5.1A	1011 = 3.1A	1111 = 1.1A		
				Current-li	mit from 2.6A to	1.78A in 0.12A de	ecrements		
SB6CL	6:4	R/W	011 (2.24A)	000 = 2.6A	010 = 2.36A	100 = 2.12A	110 = 1.88A		
			(2.247)	001 = 2.48A	011 = 2.24A	101 = 2.00A	111 = 1.76A		
	7	R/W	0	0 = Currer	nt-Limit On	1 = Currer	nt-Limit Off		

8.15 Power-on-Reset (POR) Threshold Voltage Setting Register (21'h and 22'h)

This register is used to set the rising and falling threshold of power-on-reset (POR) comparator. The POR threshold voltage setting is based on the logic level of the VSLT pin in addition to the register bits. Refer to Table 8-16 for POR time delay settings.

Condition	_			Rising and	Falling Power-C Set	On-Reset Thresh ting	old Voltage
Pin	Bit	R/W	Default		Descr	iption	
				:	3.3V to 2.3V in 50	0 mV decrements	3
				00000 = 3.25V	01000 = 2.85V	10000 = 2.45V	11000 = 2.25V
				00001 = 3.20V	01001 = 2.80V	10001 = 2.40V	11001 = 2.25V
				00010 = 3.15V	01010 = 2.75V	10010 = 2.35V	11010 = 2.25V
VSCLT	4:0	R/W	00000	00011 = 3.10V	01011 = 2.70V	10011 = 2.30V	11011 = 2.25V
				00100 = 3.05V	01100 = 2.65V	10100 = 2.25V	11100 = 2.25V
				00101 = 3.00V	01101 = 2.60V	10101 = 2.25V	11101 = 2.25V
				00110 = 2.95V	01110 = 2.55V	10110 = 2.25V	11110 = 2.25V
				00111 = 2.90V	01111 = 2.50V	10111 = 2.25V	11111 = 2.25V

The three most significant bits [7:5] in registers 21'h and 22'h are used to mask the output voltage power-good flag after the start-up sequenced is finished.

^{© 2018} Microchip Technology Inc.

Register Name	PORUP_REG		G	Power-on-Reset Rising Threshold	
Address	—			0x21'h	
Field	Bit	Bit R/W Default Description		iption	
PORUP	4:0	R/W	01011	See Table 8-27	
PGOOD_MASK 1	5	R/W	1	0 = Do not mask PGOOD1	1 = Mask PGOOD1
PGOOD_MASK 2	6	R/W	1	0 = Do not mask PGOOD2	1 = Mask PGOOD2
PGOOD_MASK 3	7	R/W	1	0 = Do not mask PGOOD3	1 = Mask PGOOD3

TABLE 8-29: POWER-ON-RESET FALLING THRESHOLD VOLTAGE SETTING REGISTER (22'H)

Register Name	PORDN_REG		G	Power-on-Reset Falling Threshold		
Address	—			0x22'h		
Field	Bit R/W Default Description		iption			
PORDN	4:0	R/W	01101	See Table 8-27		
PGOOD_MASK 4	5	R/W	1	0 = Do not mask PGOOD4	1 = Mask PGOOD4	
PGOOD_MASK 5	6	R/W	1	0 = Do not mask PGOOD5	1 = Mask PGOOD5	
PGOOD_MASK 6	7	R/W	1	0 = Do not mask PGOOD6	1 = Mask PGOOD6	

8.16 Pull-Down When Disabled Register (23'h)

This register is used to set the preference of enabling/disabling a pull-down FET when the DC/DC regulators are disabled. The pull-down value for buck regulators 1 through 5 is 90Ω . The pull-down current value for the boost regulator 6 is programmable.

Register Name	PULLDN1-6_REG		REG	Pull-Down When Disabled Register	
Address	—			0x23'h	
Field	Bit	R/W	Default	Description	
PULLD1	0	R/W	0	Enable/Disable the pull-down on Regulator 1 when power down. 0 = No Pull-Down; 1 = Pull-Down	
PULLD2	1	R/W	0	Enable/Disable the pull-down on Regulator 2 when power down. 0 = No Pull-Down; 1 = Pull-Down	
PULLD3	2	R/W	0	Enable/Disable the pull-down on Regulator 3 when power down. 0 = No Pull-Down; 1 = Pull-Down	
PULLD4	3	R/W	0	Enable/Disable the pull-down on Regulator 4 when power down. 0 = No Pull-Down; 1 = Pull-Down	
PULLD5	4	R/W	0	Enable/Disable the pull-down on Regulator 5 when power down. 0 = No Pull-Down; 1 = Pull-Down	
PULLD6C	6:5	R/W	00	Sets Boost Pull-Down Current Level 00 = 148 mA; 01 = 111 mA; 10 = 74 mA; 11 = 37 mA	
PULLD6	7	R/W	0	Enable/Disable the pull-down on Regulator 6 when power down. 0 = No Pull-Down; 1 = Pull-Down	

TABLE 8-30: PULL-DOWN WHEN DISABLED REGISTER

8.17 Internal Clock Control Register

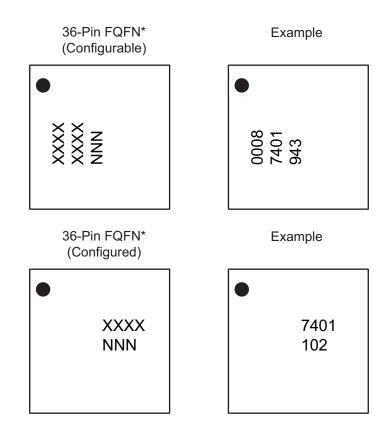
This register houses the Force_CLK_ON bit 2 used when sending the special command keys. Bit 2 of this register is used to set the PMIC clock to permanently be enabled in order to execute the new command. This bit should be cleared after the command has been executed in order to save power (the internal clock logic will shut down the clock automatically when not needed).

Register Name	Force Clock Register		gister	Internal Clock Control Register	
Address	—			0x2F'h	
Field	Bit	Bit R/W Default		Description	
	0	R/W	0	Reserved	
—	1	R/W	0	Reserved	
FORCE CLK_ON	2	R/W	0	0 = No Action. 1 = Force the internal clock to keep running and not be turned off by the power down logic.	
	3	R/W	0	Reserved	
—	4	R/W	0	Reserved	
—	5	R/W	0	Reserved	
—	6	R/W	0	Reserved	
_	7	R/W	0	Reserved	

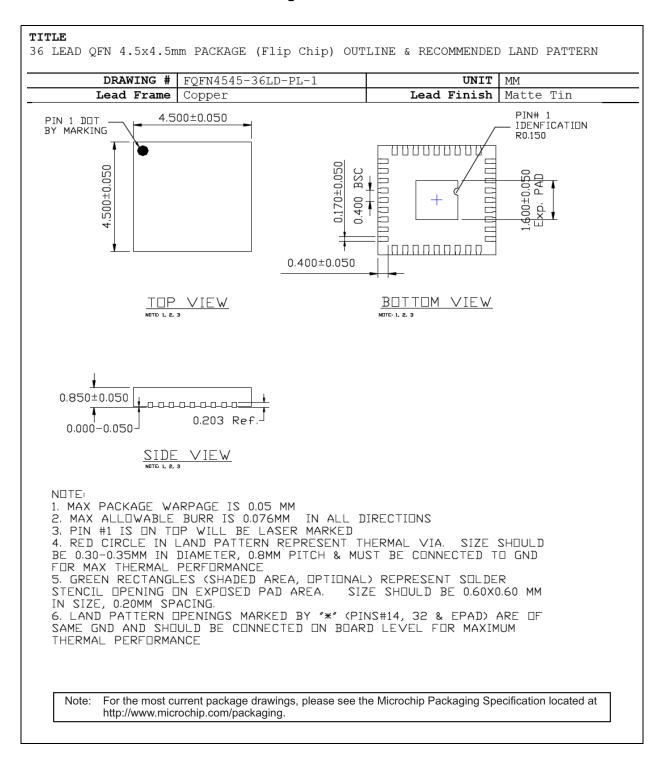
 TABLE 8-31:
 INTERNAL CLOCK CONTROL REGISTER

9.0 PACKAGING INFORMATION

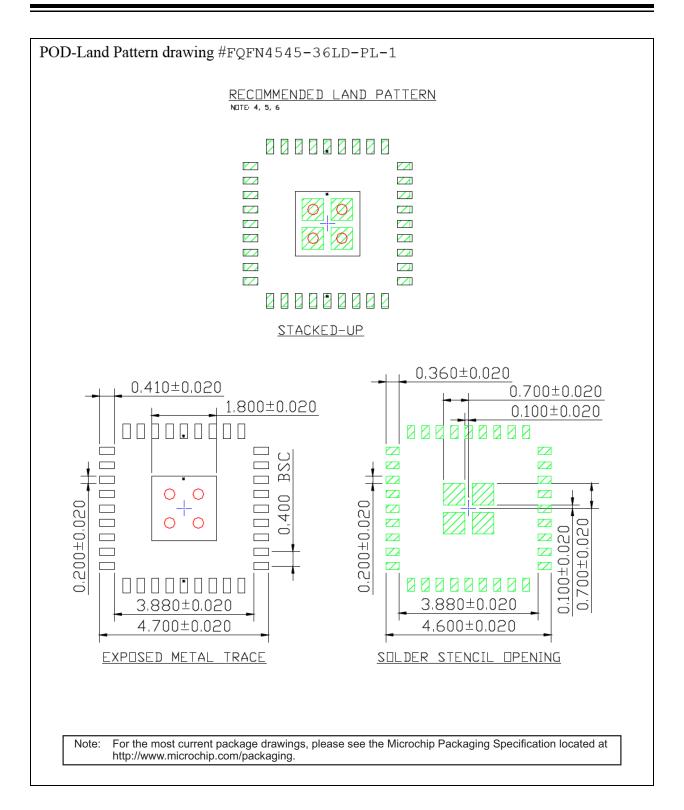
9.1 Package Marking Information



Legend	: XXX	Product code or customer-specific information				
	Y	Year code (last digit of calendar year)				
	ΥY	Year code (last 2 digits of calendar year)				
	WW	Week code (week of January 1 is week '01')				
	NNN	Alphanumeric traceability code				
	(e3) *	Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.				
	●, ▲, ▼ mark).	Pin one index is identified by a dot, delta up, or delta down (triangle				
Note:	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.					
	Underbar (_) and/or Overbar (⁻) symbol may not be to scale.					



36-Lead 4.5 mm x 4.5 mm FQFN Package Outline and Recommended Land Pattern



APPENDIX A: REVISION HISTORY

Revision A (September 2018)

- Converted Micrel document MIC7401 to Microchip data sheet DS20005618A.
- Minor text changes throughout.

 $[\]ensuremath{\textcircled{}^{\odot}}$ 2018 Microchip Technology Inc.

MIC7401

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>PART NO.</u> _>	xxx x xx -xx	Examples:		
Device O	Itput Junction Temp. Package Media Type tages Range MIC7401: Configurable PMIC, Five Channel Buck	a) MIC7401YFL-T5:	MIC7401, 1.8V, 1.1V, 1.8V, 1.05V, 1.25V, 12V Output Volt- ages, –40°C to +125°C Temp. Range, 36-Lead FQFN, 500/ Reel	
Output Voltages:	Regulator Plus One Boost with HyperLight Load [®] , I ² C Control, and Enable <blank>= 1.8V, 1.1V, 1.8V, 1.05V, 1.25V, 12V</blank>	b) MIC7401- XXXXYFL-TR:	MIC7401, Configurable Output Voltages, -40°C to +125°C Temp. Range, 36-Lead FQFN, 5,000/Reel	
Junction Temperature	$XXXX = Configurable (Contact Marketing for Options)$ $Y = -40^{\circ}C \text{ to } +125^{\circ}C$	c) MIC7401YFL:	MIC7401, 1.8V, 1.1V, 1.8V, 1.05V, 1.25V, 12V Output Volt- ages, –40°C to +125°C Temp. Range, 36-Lead FQFN, 1/Tube	
Range: Package:	FL = 36-Lead 4.5 mm x 4.5 mm FQFN	d) MIC7401- XXXXYFL-T5:	MIC7401, Configurable Output Voltages, -40°C to +125°C Temp. Range, 36-Lead FQFN, 500/Reel	
Media Type:	 	catalog part used for oro the device p	eel identifier only appears in the number description. This identifier is lering purposes and is not printed on package. Check with your Microchip e for package availability with the eel option.	

^{© 2018} Microchip Technology Inc.

MIC7401

NOTES:

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, AVR, AVR logo, AVR Freaks, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KeeLoq, Kleer, LANCheck, LINK MD, maXStylus, maXTouch, MediaLB, megaAVR, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, Prochip Designer, QTouch, SAM-BA, SpyNIC, SST, SST Logo, SuperFlash, tinyAVR, UNI/O, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, EtherSynch, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and Quiet-Wire are registered trademarks of Microchip Technology Incorporated in the U.S.A. Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, INICnet, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, memBrain, Mindi, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2018, Microchip Technology Incorporated, All Rights Reserved. ISBN: 978-1-5224-3576-1



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

Canada - Toronto Tel: 905-695-1980 Fax: 905-695-2078

DS20005618A-page 62

ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

China - Beijing Tel: 86-10-8569-7000 China - Chengdu

Tel: 86-28-8665-5511 China - Chongqing Tel: 86-23-8980-9588

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

China - Shenyang Tel: 86-24-2334-2829

China - Shenzhen Tel: 86-755-8864-2200

China - Suzhou Tel: 86-186-6233-1526

China - Wuhan Tel: 86-27-5980-5300

China - Xian Tel: 86-29-8833-7252

China - Xiamen Tel: 86-592-2388138 China - Zhuhai

Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

India - New Delhi Tel: 91-11-4160-8631 India - Pune

Tel: 91-20-4121-0141

Japan - Osaka Tel: 81-6-6152-7160

Japan - Tokyo Tel: 81-3-6880- 3770

Korea - Daegu Tel: 82-53-744-4301

Korea - Seoul Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

Singapore Tel: 65-6334-8870

Taiwan - Hsin Chu Tel: 886-3-577-8366

Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100

Tel: 31-416-690399 Fax: 31-416-690340

Italy - Padova

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Tel: 45-4450-2828

Fax: 45-4485-2829

Tel: 358-9-4520-820

Tel: 33-1-69-53-63-20

Fax: 33-1-69-30-90-79

Germany - Garching

Tel: 49-2129-3766400

Germany - Heilbronn

Germany - Karlsruhe

Tel: 49-721-625370

Germany - Munich

Tel: 49-89-627-144-0

Fax: 49-89-627-144-44

Germany - Rosenheim

Tel: 49-8031-354-560

Israel - Ra'anana

Italy - Milan

Tel: 972-9-744-7705

Tel: 39-0331-742611

Fax: 39-0331-466781

Tel: 39-049-7625286

Netherlands - Drunen

Tel: 49-7131-67-3636

Tel: 49-8931-9700

Germany - Haan

Finland - Espoo

France - Paris

Fax: 43-7242-2244-393

Denmark - Copenhagen

Norway - Trondheim Tel: 47-7288-4388

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

© 2018 Microchip Technology Inc. 08/15/18